

LTC2000A

### 16-/14-/11-Bit 2.7Gsps DACs

### FEATURES

- 80dBc SFDR at 50MHz f<sub>OUT</sub>
- >68dBc SFDR from DC to 1080MHz f<sub>OUT</sub>
- 40mA Nominal Full-Scale, ±1V Output Compliant
- 10mA to 60mA Adjustable Full-Scale Current Range
- Single or Dual Port DDR LVDS and DHSTL Interface
- Low Latency (7.5 Cycles for Single Port, 11 Cycles for Dual Port)
- >78dBc 2-Tone IMD from DC to 1000MHz f<sub>OUT</sub>
- –156dBc/Hz Additive Phase Noise at 1MHz Offset for 65MHz f<sub>OUT</sub>
- 170-Lead (9mm × 15mm) BGA Package

### **APPLICATIONS**

- Broadband Communication Systems
- DOCSIS CMTS
- Direct RF Synthesis
- Radar
- Instrumentation
- Automatic Test Equipment

#### TSTP/N SVDD SDO PD CS SCK SDI JUNCTION PATTERN SP TEMPERATURE GENERATOR DAP/N[15:0] **I**OUTP DATA FLIP-FLOPS €50Ω RECEIVERS 4. 16-BIT DAC DBP/N[15:0] 500 IOUTN DDR LVDS GAIN ADJUST DCKIP/N DELAY CLOCK FSAD, ADJUST SYNC **REFIO** DCKOP/N CLK DIVIDER CLK **₹**10k RECEIVER ÷2 0R ÷4 REF CKP/N DV<sub>DD33</sub> GND AV<sub>DD18</sub> DV<sub>DD18</sub> AV<sub>DD33</sub>

### DESCRIPTION

The LTC<sup>®</sup>2000A is a family of 16-/14-/11-bit 2.7Gsps current steering DACs with exceptional spectral purity.

The single (1.35Gsps mode) or dual (2.7Gsps mode) port source synchronous LVDS interface supports data rates of up to 1.35Gbps using a 675MHz DDR data clock, which can be either in quadrature or in phase with the data. An internal synchronizer automatically aligns the data with the DAC sample clock.

Additional features such as pattern generation, LVDS loopout and junction temperature sensing simplify system development and testing.

A serial peripheral interface (SPI) port allows configuration and read back of internal registers. Operating from 1.86V and 3.3V supplies, the LTC2000A consumes 2.41W at 2.7Gsps and 1.43W at 1.35Gsps.

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#### 2000afb

**BLOCK DIAGRAM** 

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### ABSOLUTE MAXIMUM RATINGS (Notes 1, 2)

| AV <sub>DD33</sub> , DV <sub>DD33</sub> , | SV <sub>DD</sub> | 0.3V to 4V                        |
|---|------------------|-----------------------------------|
| AV <sub>DD18</sub> , DV <sub>DD18</sub> . |                  | 0.3V to 2V                        |
| IOUTP, IOUTN                              | –1.2V to Mi      | n (AV <sub>DD33</sub> + 0.3V, 4V) |
| FSADJ, REFIO                              | 0.3V to Mi       | n (AV <sub>DD33</sub> + 0.3V, 4V) |
| DCKIP, DCKIN                              | –0.3V to Mir     | n (DV <sub>DD33</sub> + 0.3V, 4V) |
| DCKOP, DCKON                              | –0.3V to Mir     | n (DV <sub>DD33</sub> + 0.3V, 4V) |
| DAP/N, DBP/N                              | –0.3V to Mir     | n (DV <sub>DD33</sub> + 0.3V, 4V) |
| TSTP, TSTN                                | 0.3V to Mi       | n (AV <sub>DD33</sub> + 0.3V, 4V) |

| CKP, CKN0.3V to Min (AV              | / <sub>DD18</sub> + 0.3V, 2V) |
|--------------------------------------|-------------------------------|
| CS, PD, SCK, SDI, SDO0.3V to Min (S  | SV <sub>DD</sub> + 0.3V, 4V)  |
| Operating Temperature Range          |                               |
| LTC2000AC                            | 0°C to 70°C                   |
| LTC2000AI                            | 40°C to 85°C                  |
| Maximum Junction Temperature         | 125°C                         |
| Storage Temperature Range            | . –55°C to 125°C              |
| Lead Temperature (Soldering, 10 sec) | 260°C                         |

### PIN CONFIGURATION



### ORDER INFORMATION http://www.linear.com/product/LTC2000A#orderinfo



| PART NUMBER       | BALL FINISH   | PART MARKING* | PACKAGE TYPE | MSL RATING | TEMPERATURE RANGE |
|-------------------|---------------|---------------|--------------|------------|-------------------|
| LTC2000ACY-16#PBF | SAC305 (RoHS) | LTC2000Y-16   | BGA          | 3          | 0°C to 70°C       |
| LTC2000ACY-14#PBF | SAC305 (RoHS) | LTC2000Y-14   | BGA          | 3          | 0°C to 70°C       |
| LTC2000ACY-11#PBF | SAC305 (RoHS) | LTC2000Y-11   | BGA          | 3          | 0°C to 70°C       |
| LTC2000AIY-16#PBF | SAC305 (RoHS) | LTC2000Y-16   | BGA          | 3          | -40°C to 85°C     |
| LTC2000AIY-14#PBF | SAC305 (RoHS) | LTC2000Y-14   | BGA          | 3          | -40°C to 85°C     |
| LTC2000AIY-11#PBF | SAC305 (RoHS) | LTC2000Y-11   | BGA          | 3          | –40°C to 85°C     |
| LTC2000AIY-16     | Sn/Pb         | LTC2000Y-16   | BGA          | 3          | -40°C to 85°C     |

Consult ADI Marketing for parts specified with wider operating temperature ranges. \*The temperature grade is identified by a label on the shipping container.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/

This product is only offered in trays. For more information go to: http://www.linear.com/packaging/. Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

**ELECTRICAL CHARACTERISTICS** The • denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^{\circ}$ C.  $AV_{DD18}$ ,  $DV_{DD18} = 1.8V$  to 1.92V,  $AV_{DD33}$ ,  $DV_{DD33} = 3.135V$  to 3.465V,  $SV_{DD} = 1.71V$  to 3.465V,  $R_{FSADJ} = 500\Omega$ ,  $12.5\Omega$  load from  $I_{OUTP/N}$  to GND including internal  $50\Omega$  termination, unless otherwise specified.

| SYMBOL    | PARAMETER                                 | CONDITIONS   |   | MIN  | ТҮР                  | MAX   | UNITS  |
|-----------|---|--|---|------|----------------------|-------|--------|
| DC Perfor | mance                                     |  |   |      |                      |       |        |
|           | Resolution                                | LTC2000A-16  | ٠ | 16   |                      |       | Bits   |
|           |   | LTC2000A-14  | ٠ | 14   |                      |       | Bits   |
|           |   | LTC2000A-11  | ٠ | 11   |                      |       | Bits   |
| DNL       | Differential Nonlinearity                 | LTC2000A-16  | ٠ |      | ±0.5                 | ±2.7  | LSB    |
|           |   | LTC2000A-14  | ٠ |      | ±0.2                 | ±1    | LSB    |
|           |   | LTC2000A-11  | ٠ |      | ±0.1                 | ±0.5  | LSB    |
| INL       | Integral Nonlinearity                     | LTC2000A-16  | ٠ |      | ±1                   | ±4    | LSB    |
|           |   | LTC2000A-14  | ٠ |      | ±0.5                 | ±2    | LSB    |
|           |   | LTC2000A-11  | ٠ |      | ±0.2                 | ±1    | LSB    |
|           | Offset Error                              | LTC2000A-16  | ٠ |      |                      | ±0.05 | % FSR  |
|           |   | LTC2000A-14  | • |      |                      | ±0.06 | % FSR  |
|           |   | LTC2000A-11  | ٠ |      |                      | ±0.09 | % FSR  |
|           | Offset Error Drift                        |  |   |      | 1                    |       | ppm/°C |
|           | Gain Error                                |  |   |      | ±0.5                 |       | % FSR  |
|           | Gain Error Drift                          |  |   |      | 5                    |       | ppm/°C |
|           | Power Supply Rejection Ratio              | Full-Scale; AV <sub>DD33</sub> = 3.135V to 3.465V                                  |   |      | 69                   |       | dB     |
| Analog Ou | itput                                     |  |   |      |                      |       |        |
|           | Full-Scale Output Current                 | $R_{FSADJ} = 500\Omega$  |   |      | 40                   |       | mA     |
|           | Output Compliance Range                   |  | • | -1   |                      | 1     | V      |
|           | Output Resistance                         | I <sub>OUTP/N</sub> to GND   | • | 42   | 50                   | 58    | Ω      |
|           | Output Capacitance                        |  |   |      | 6                    |       | pF     |
|           | Output Bandwidth                          | $R_{IOUTP/N} = 12.5\Omega$ , -3dB Excluding sin(x)/x                               |   |      | 2.1                  |       | GHz    |
| AC Perfor | mance                                     |  |   |      |                      |       | L      |
|           | Maximum Update Rate                       | Dual-Port Mode   |   | 2.7  |                      |       | Gsps   |
|           |   | Single-Port Mode   | • | 1.35 |                      |       | Gsps   |
| SFDR      | Spurious Free Dynamic Range               | $f_{OUT} = 50MHz$ , LIN_DIS = 0, LIN_GN = 75%                                      |   |      | 82                   |       | dBc    |
|           | $T_{DAC} = 1.25GSps, UdBFS$               | $T_{OUT} = 100MHZ$ , LIN_DIS = 0, LIN_GN = 75%                                     |   |      | 82<br>74             |       | dBc    |
|           |   | $f_{OUT} = 500MHz$ , LIN_DIS = 0, LIN_GN = 75%                                     |   |      | 74                   |       | dBc    |
|           | Spurious Free Dynamic Range               | f <sub>OUT</sub> = 100MHz, LIN_DIS = 0, LIN_GN = 75%                               |   |      | 75                   |       | dBc    |
|           | $f_{DAC} = 2.7 Gsps, 0 dBFS$              | f <sub>OUT</sub> = 200MHz, LIN_DIS = 0, LIN_GN = 75%                               | • | 67   | 72                   |       | dBc    |
|           |   | $t_{OUT} = 500MHz$ , LIN_DIS = 0, LIN_GN = 75%                                     |   |      | /5<br>72             |       | dBc    |
|           |   | $f_{001} = 1000 \text{MHz}, \text{LIN_DIS} = 0, \text{LIN_GN} = 73\%$              |   |      | 67                   |       | dBo    |
|           |   | $f_{OUT} = 1000 \text{MHz}, \text{LIN}_\text{DIS} = 1$                             |   |      | 61                   |       | dBc    |
| IMD       | 2-Tone Intermodulation Distortion         | $f_{OUT} = 50MHz, LIN_DIS = 0, LIN_GN = 75\%$                                      |   |      | 103                  |       | dBc    |
|           | $f_{OUT2} = f_{OUT1} + 1.25MHz$           | $f_{OUT} = 100MHz$ , LIN_DIS = 0, LIN_GN = 75%                                     |   |      | 93                   |       | dBc    |
|           | $f_{DAC} = 1.25Gsps, -6dBFS$              | $f_{OUT} = 250MHz$ , LIN_DIS = 0, LIN_GN = 75%                                     |   |      | 97<br>97             |       | dBc    |
|           | 2-Topo Intermodulation Distortion         | $f_{001} = 300 \text{MHz}, \text{LIN}_\text{DIS} = 0, \text{LIN}_\text{GN} = 73\%$ |   |      | 0 <del>4</del><br>97 |       | dBo    |
|           | $f_{0,172} = f_{0,171} + 1.25 \text{MHz}$ | $f_{001} = 100MHz$ , LIN_DIS = 1   |   |      | 86                   |       | dBc    |
|           | f <sub>DAC</sub> = 2.7Gsps, –6dBFS        | $f_{OUT} = 500MHz$ , LIN_DIS = 1   |   |      | 82                   |       | dBc    |
|           |   | t <sub>OUT</sub> = 1000MHz, LIN_DIS = 1  |   |      | 80                   |       | dBc    |
|           |   | $f_{OUT} = 500$ MHz, LIN_DIS = 0, LIN_GN = 75%                                     |   |      | 79<br>68             |       | dBc    |
|           |   | $1001 = 10000012, L10_013 = 0, L10_010 = 75\%$                                     |   |      | 00                   |       |        |

Г С

**ELECTRICAL CHARACTERISTICS** The  $\bullet$  denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C. AV<sub>DD18</sub>, DV<sub>DD18</sub> = 1.8V to 1.92V, AV<sub>DD33</sub>, DV<sub>DD33</sub> = 3.135V to 3.465V, SV<sub>DD</sub> = 1.71V to 3.465V, R<sub>FSADJ</sub> = 500 $\Omega$ , 12.5 $\Omega$  load from I<sub>OUTP/N</sub> to GND including internal 50 $\Omega$  termination, unless otherwise specified.

| SYMBOL        | PARAMETER   | CONDITIONS   | MIN   | ТҮР                          | MAX   | UNITS                                |
|---------------|---|--|-------|------------------------------|-------|--------------------------------------|
| NSD           | Noise Spectral Density<br>OdBFS Single Tone, f <sub>DAC</sub> = 2.7Gsps,<br>I <sub>OUTFS</sub> = 40mA               | LTC2000A-16, $f_{OUT}$ = 100MHz<br>LTC2000A-16, $f_{OUT}$ = 350MHz<br>LTC2000A-16, $f_{OUT}$ = 550MHz<br>LTC2000A-16, $f_{OUT}$ = 950MHz |       | -164<br>-158<br>-155<br>-153 |       | dBm/Hz<br>dBm/Hz<br>dBm/Hz<br>dBm/Hz |
|               |   | LTC2000A-14, $f_{OUT}$ = 100MHz<br>LTC2000A-14, $f_{OUT}$ = 350MHz<br>LTC2000A-14, $f_{OUT}$ = 550MHz<br>LTC2000A-14, $f_{OUT}$ = 950MHz |       | -163<br>-158<br>-155<br>-153 |       | dBm/Hz<br>dBm/Hz<br>dBm/Hz<br>dBm/Hz |
|               |   | LTC2000A-11, $f_{OUT}$ = 100MHz<br>LTC2000A-11, $f_{OUT}$ = 350MHz<br>LTC2000A-11, $f_{OUT}$ = 550MHz<br>LTC2000A-11, $f_{OUT}$ = 950MHz |       | -156<br>-154<br>-153<br>-150 |       | dBm/Hz<br>dBm/Hz<br>dBm/Hz<br>dBm/Hz |
|               | Phase Noise<br>f <sub>DAC</sub> = 2.7Gsps, f <sub>OUT</sub> = 65MHz<br>0dBFS Single Tone, I <sub>OUTFS</sub> = 40mA | 10kHz Offset<br>1MHz Offset  |       | -141<br>-156                 |       | dBc/Hz<br>dBc/Hz                     |
| WCDMA<br>ACLR | WCDMA ACLR (Single Carrier)<br>Adjacent/Alternate Adjacent Channel  | f <sub>DAC</sub> = 2.7Gsps, f <sub>OUT</sub> = 350MHz<br>f <sub>DAC</sub> = 2.7Gsps, f <sub>OUT</sub> = 950MHz                           |       | 78/79<br>72/75               |       | dBc<br>dBc                           |
| Latency       |   |  | <br>  |                              |       |                                      |
|               | Latency (Note 5)  | Single-Port Mode<br>Dual-Port Mode, DAP/N Data<br>Dual-Port Mode, DBP/N Data   |       | 7.5<br>10<br>11              |       | Cycles<br>Cycles<br>Cycles           |
|               | Aperture Delay  | CKP/N Rising to I <sub>OUTP/N</sub> Transition   |       | 3                            |       | ns                                   |
|               | Settling Time   | ±0.1% FSR, Full-Scale Step   |       | 2.2                          |       | ns                                   |
| Reference     |   |  |       |                              |       |                                      |
|               | Output Voltage  |  | 1.225 | 1.25                         | 1.275 | V                                    |
|               | Input Voltage   |  | 1.1   |                              | 1.4   | V                                    |
|               | Reference Temperature Coefficient   |  |       | ±25                          |       | ppm/°C                               |
|               | Output Impedance  |  |       | 10                           |       | kΩ                                   |
| DAC Clock     | Inputs (CKP, CKN)   |  |       |                              |       |                                      |
|               | Differential Input Voltage Range  |  | ±0.3  |                              | ±1.8  | V                                    |
|               | Common-Mode Input Voltage   | Set Internally   |       | 1                            |       | V                                    |
|               | Sampling Clock Frequency  |  | 50    |                              | 2700  | MHz                                  |
|               | Input Impedance   |  |       | 5                            |       | kΩ                                   |
| LVDS Input    | s (DCKIP, DCKIN, DAP/N, DBP/N)  |  |       |                              |       |                                      |
|               | Differential Input Voltage Range  |  | ±0.2  |                              | ±0.6  | V                                    |
|               | Common-Mode Voltage Range   |  | 0.4   |                              | 1.8   | V                                    |
|               | Differential Input Impedance  |  | 95    | 120                          | 145   | Ω                                    |
|               | Maximum Data Rate   | -  |       |                              | 1350  | Mbps                                 |
|               | LVDS Clock Frequency  |  | 25    |                              | 675   | MHz                                  |

**ELECTRICAL CHARACTERISTICS** The  $\bullet$  denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C. AV<sub>DD18</sub>, DV<sub>DD18</sub> = 1.8V to 1.92V, AV<sub>DD33</sub>, DV<sub>DD33</sub> = 3.135V to 3.465V, SV<sub>DD</sub> = 1.71V to 3.465V, R<sub>FSADJ</sub> = 500 $\Omega$ , 12.5 $\Omega$  load from I<sub>OUTP/N</sub> to GND including internal 50 $\Omega$  termination, unless otherwise specified.

| SYMBOL              | PARAMETER  | CONDITIONS  |             | MIN          | ТҮР                      | MAX                     | UNITS                |
|---------------------|--|---|-------------|--------------|--------------------------|-------------------------|----------------------|
| LVDS Outp           | out (DCKOP, DCKON)   | J   |             |              |                          |                         |                      |
|                     | Differential Output Voltage  | 100Ω Differential Load, DCKO_ISEL = 0<br>50Ω Differential Load, DCKO_ISEL = 1   | •           | 0.24<br>0.24 | 0.36<br>0.36             | 0.48<br>0.48            | V<br>V               |
|                     | Common-Mode Output Voltage   |   | •           | 1.075        | 1.2                      | 1.325                   | V                    |
|                     | Internal Termination Resistance                                      | DCKO_TRM = 1  |             |              | 100                      |                         | Ω                    |
| CMOS Dig            | ital Inputs (CS, PD, SCK, SDI)                                       |   |             |              |                          |                         |                      |
| V <sub>IH</sub>     | Digital Input High Voltage   |   |             | 70           |                          |                         | %V <sub>SVDD</sub>   |
| V <sub>IL</sub>     | Digital Input Low Voltage  |   | •           |              |                          | 30                      | %V <sub>SVDD</sub>   |
| I <sub>LK</sub>     | Digital Input Leakage  | V <sub>IN</sub> = GND or SV <sub>DD</sub>   |             |              |                          | ±10                     | μA                   |
| CIN                 | Digital Input Capacitance  |   |             |              | 8                        |                         | pF                   |
| CMOS Dig            | ital Output (SDO)  |   |             |              |                          |                         |                      |
| V <sub>OH</sub>     | Digital Output High Voltage  | I <sub>SOURCE</sub> = 0.2mA   |             | 85           |                          |                         | %V <sub>SVDD</sub>   |
| V <sub>OL</sub>     | Digital Output Low Voltage   | I <sub>SINK</sub> = 1.6mA   | •           |              |                          | 15                      | %V <sub>SVDD</sub>   |
|                     | Hi-Z Output Leakage  |   |             |              |                          | ±10                     | μA                   |
|                     | Hi-Z Output Capacitance  |   |             |              | 8                        |                         | pF                   |
| Power Sup           | oply   |   |             |              |                          |                         |                      |
| V <sub>VDD33</sub>  | AV <sub>DD33</sub> , DV <sub>DD33</sub> Supply Voltage               |   | •           | 3.135        | 3.3                      | 3.465                   | V                    |
| V <sub>VDD18</sub>  | AV <sub>DD18</sub> , D <sub>VDD18</sub> Supply Voltage               |   | •           | 1.8          | 1.86                     | 1.92                    | V                    |
| V <sub>SVDD</sub>   | SV <sub>DD</sub> SPI Supply Voltage                                  |   | •           | 1.71         |                          | 3.465                   | V                    |
| I <sub>AVDD33</sub> | AV <sub>DD33</sub> Supply Current, AV <sub>DD33</sub> = 3.3V         | $\frac{\overline{PD}}{\overline{PD}} = SV_{DD}$<br>PD = GND   | •           |              | 68<br>0.1                | 78<br>10                | mA<br>μA             |
| I <sub>DVDD33</sub> | DV <sub>DD33</sub> Supply Current, DV <sub>DD33</sub> = 3.3V         | $\frac{\overline{PD}}{\overline{PD}} = SV_{DD}$<br>$\overline{PD} = GND$  | •           |              | 8<br>0.1                 | 14<br>5                 | mA<br>μA             |
| I <sub>AVDD18</sub> | AV <sub>DD18</sub> Supply Current, AV <sub>DD18</sub> = 1.86V        | $ \begin{array}{l} f_{DAC} = 2700 MHz \\ f_{DAC} = 1350 MHz \\ f_{DAC} = 0 Hz, \ \overline{PD} = SV_{DD} \\ f_{DAC} = 0 Hz, \ \overline{PD} = GND \end{array} $ | •<br>•<br>• |              | 780<br>425<br>23<br>3    | 870<br>480<br>27<br>180 | mA<br>mA<br>mA<br>μA |
| I <sub>DVDD18</sub> | DV <sub>DD18</sub> Supply Current, DV <sub>DD18</sub> = 1.86V        |   | •<br>•<br>• |              | 380<br>210<br>10<br>0.1  | 440<br>240<br>14<br>240 | mA<br>mA<br>mA<br>μA |
| I <sub>SVDD</sub>   | SV <sub>DD</sub> Supply Current (Note 4),<br>SV <sub>DD</sub> = 3.3V | f <sub>SCK</sub> = 0Hz  |             |              | 0.1                      | 5                       | μA                   |
|                     | Total Power Dissipation  |   |             |              | 2408<br>1432<br>312<br>6 |                         | mW<br>mW<br>mW<br>μW |

**TIMING CHARACTERISTICS** The  $\bullet$  denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C. AV<sub>DD18</sub>, DV<sub>DD18</sub> = 1.8V to 1.92V, AV<sub>DD33</sub>, DV<sub>DD33</sub> = 3.135V to 3.465V, SV<sub>DD</sub> = 1.71V to 3.465V, R<sub>FSADJ</sub> = 500 $\Omega$ , output load 50 $\Omega$  double terminated, unless otherwise specified.

| SYMBOL          | PARAMETER                                       | CONDITIONS                                |   | MIN         | ТҮР | MAX | UNITS    |
|-----------------|---|---|---|-------------|-----|-----|----------|
| t <sub>1</sub>  | SDI Valid to SCK Setup                          | (Note 3)                                  | ٠ | 4           |     |     | ns       |
| t <sub>2</sub>  | SDI Valid to SCK Hold                           | (Note 3)                                  | ٠ | 4           |     |     | ns       |
| t <sub>3</sub>  | SCK High Time                                   | (Note 3)                                  | • | 9           |     |     | ns       |
| t <sub>4</sub>  | SCK Low Time                                    | (Note 3)                                  |   | 9           |     |     | ns       |
| t <sub>5</sub>  | CS Pulse Width                                  | (Note 3)                                  |   | 10          |     |     | ns       |
| t <sub>6</sub>  | SCK High to CS High                             | (Note 3)                                  | ٠ | 7           |     |     | ns       |
| t <sub>7</sub>  | CS Low to SCK High                              | (Note 3)                                  | ٠ | 7           |     |     | ns       |
| t <sub>10</sub> | CS High to SCK High                             | (Note 3)                                  | ٠ | 7           |     |     | ns       |
| t <sub>13</sub> | SCK Low to SDO Valid                            | Unloaded (Note 3)                         | ٠ | 10          |     |     | ns       |
|                 | SCK Frequency                                   | 50% Duty Cycle (Note 3)                   | ٠ |             |     | 50  | MHz      |
| t <sub>11</sub> | LVDS DAP/N, DBP/N to DCKI Setup Time (Note 3)   | DCKI_Q = 1<br>DCKI_Q = 0, DCKI_TADJ = 000 | • | 200<br>570  |     |     | ps<br>ps |
| t <sub>12</sub> | LVDS DAP/N, DBP/N to DCKI Hold Time<br>(Note 3) | DCKI_Q = 1<br>DCKI_Q = 0, DCKI_TADJ = 000 | • | 200<br>–170 |     |     | ps<br>ps |

**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

**Note 2:** All voltages are with respect to GND.

Note 3: Guaranteed by design and not production tested.

Note 4: Digital inputs at OV or  $SV_{DD}$ .

**Note 5:** Latency is the delay from a transition on DCKIP/N until the CKP/N transition which causes the sample on DAP/N or DBP/N to appear at the DAC output  $I_{OUTP/N}$ , as measured in DAC sample clock (CKP/N) cycles.

# **TYPICAL PERFORMANCE CHARACTERISTICS** $I_{OUTFS} = 40$ mA, $T_A = 25^{\circ}$ C, $AV_{DD18} = DV_{DD18} = 1.86V$ , $AV_{DD33} = DV_{DD33} = 3.3V$ , $R_{LOAD} = 12.5\Omega$ , unless otherwise noted.



f<sub>OUT</sub> (MHz)

2000A G16

## **TYPICAL PERFORMANCE CHARACTERISTICS** $I_{OUTFS} = 40$ mA, $T_A = 25$ °C, $AV_{DD18} = DV_{DD18} = 1.86V$ , $AV_{DD33} = DV_{DD33} = 3.3V$ , $R_{LOAD} = 12.5\Omega$ , $LIN_{DIS} = 0$ , $LIN_{GN} = 75\%$ unless otherwise noted.





f<sub>OUT</sub> (MHz)

2000A G17

n

f<sub>OUT</sub> (MHz)

> 2000A G18 2000afb

## **TYPICAL PERFORMANCE CHARACTERISTICS** $I_{OUTFS} = 40$ mA, $T_A = 25^{\circ}$ C, $AV_{DD18} = DV_{DD18} = 1.86V$ , $AV_{DD33} = DV_{DD33} = 3.3V$ , $R_{LOAD} = 12.5\Omega$ , $LIN_DIS = 0$ , $LIN_GN = 75\%$ unless otherwise noted.



2-Tone IMD vs four and fDAC with **Default Linearization** 







2-Tone IMD vs f<sub>OUT</sub> and Linearization Setting,

2000A G20



LTC2000A-16 Single-Tone NSD vs four and fDAC



2-Tone IMD vs f<sub>OUT</sub> and Digital Amplitude,  $f_{DAC} = 2.7Gsps$ 



SFDR vs four and Linearization Setting, f<sub>DAC</sub> = 2.7Gsps



LTC2000A-16 Single-Tone NSD vs four and loures



# **TYPICAL PERFORMANCE CHARACTERISTICS** $I_{OUTFS} = 40$ mA, $T_A = 25$ °C, $AV_{DD18} = DV_{DD18} = 1.86V$ , $AV_{DD33} = DV_{DD33} = 3.3V$ , $R_{LOAD} = 12.5\Omega$ , $LIN_{DIS} = 0$ , $LIN_{GN} = 75\%$ unless otherwise noted.

#### LTC2000A-16



## **TYPICAL PERFORMANCE CHARACTERISTICS** $I_{OUTFS} = 40$ mA, $T_A = 25^{\circ}$ C, $AV_{DD18} = DV_{DD18} = 1.86V$ , $AV_{DD33} = DV_{DD33} = 3.3V$ , $R_{LOAD} = 12.5\Omega$ , $LIN_DIS = 0$ , $LIN_GN = 75\%$ unless otherwise noted.

#### LTC2000A-16

24 00MHz

6MHz

-28 74dBm

-95 75dBm

24.00MHz

6MHz

-94.17dBm

-29.04dBm

24.00MHz

6MHz

-89 38dBm



-29 56dBm

# **TYPICAL PERFORMANCE CHARACTERISTICS** $I_{0UTFS} = 40$ mA, $T_A = 25$ °C, $AV_{DD18} = DV_{DD18} = 1.86V$ , $AV_{DD33} = DV_{DD33} = 3.3V$ , $R_{LOAD} = 12.5\Omega$ , $LIN\_DIS = 0$ , $LIN\_GN = 75\%$ unless otherwise noted.

#### LTC2000A-16



## **TYPICAL PERFORMANCE CHARACTERISTICS** $I_{OUTFS} = 40 \text{mA}, T_A = 25^{\circ}\text{C}, AV_{DD18} = DV_{DD18} = 1.86V, AV_{DD33} = 0, SV, R_{L0AD} = 12.5\Omega, LIN_DIS = 0, LIN_GN = 75\%$ unless otherwise noted.



# **TYPICAL PERFORMANCE CHARACTERISTICS** $I_{OUTFS} = 40$ mA, $T_A = 25^{\circ}$ C, $AV_{DD18} = DV_{DD18} = 1.86$ V, $AV_{DD33} = DV_{DD33} = 3.3$ V, $R_{LOAD} = 12.5\Omega$ , $LIN_DIS = 0$ , $LIN_GN = 75^{\circ}$ unless otherwise noted.

![](_page_15_Figure_3.jpeg)

### PIN FUNCTIONS

**AV<sub>DD18</sub>:** 1.8V Analog Supply Voltage Input. 1.8V to 1.92V.

**AV<sub>DD33</sub>:** 3.3V Analog Supply Voltage Input. 3.135V to 3.465V.

**CKP, CKN:** DAC Sample Clock Inputs. Maximum clock frequency ( $f_{DAC}$ ) is 2700MHz. Clock signal should be AC coupled.

 $\overline{CS}$ : Serial Interface Chip Select Input. When  $\overline{CS}$  is low, SCK is enabled for shifting data on SDI into the register. When  $\overline{CS}$  is taken high, SCK is disabled and SDO is high impedance.

**DAP[15:0], DAN[15:0]:** Port A LVDS Data Inputs. Maximum data rate is 1.35Gbps. Port A is used only in dual-port mode. Connect to GND if not used. The data input format is two's complement.

**DBP[15:0], DBN[15:0]:** Port B LVDS Data Inputs. Maximum data rate is 1.35Gbps. In single-port mode, only Port B is used. In dual-port mode, the sample from Port B appears at I<sub>OUTP/N</sub> one cycle after the sample from Port A. The data input format is two's complement.

**DCKIP, DCKIN:** LVDS Data Clock Inputs. Maximum frequency ( $f_{DCKI}$ ) is 675MHz. In dual-port mode,  $f_{DCKI} = f_{DAC}/4$ . In single-port mode,  $f_{DCKI} = f_{DAC}/2$ 

**DCKOP, DCKON:** LVDS Data Clock Outputs. Maximum frequency is 675MHz. Select frequency ( $f_{DAC}/4$  or  $f_{DAC}/2$ ), output current (3.5mA or 7mA), and termination (none or 100 $\Omega$ ) using register 0x02.

DV<sub>DD18</sub>: 1.8V Digital Supply Voltage Input. 1.8V to 1.92V.

**DV<sub>DD33</sub>:** 3.3V Digital Supply Voltage Input. 3.135V to 3.465V.

**FSADJ:** Full-Scale Adjust Pin. The DAC full-scale current is  $16 \cdot (V_{REFIO}/R_{FSADJ})$ . Connect a 500 $\Omega$  resistor from FSADJ to GND to set the full-scale current to 40mA.

GND: Ground.

**I**<sub>OUTP</sub>, **I**<sub>OUTN</sub>: DAC Analog Current Outputs. Differential output is nominally  $\pm$ 40mA. Maximum update rate is 2.7Gsps. The output current is evenly divided between I<sub>OUTP</sub> and I<sub>OUTN</sub> when the two's compliment DAC code is set to mid-scale (all zeros).

**PD** (Pin S1): Active Low Power-Down Input. When  $\overline{PD}$  is low, the LTC2000A supply current is less than 440µA. To exit power-down mode switch  $\overline{PD}$  high to SV<sub>DD</sub>.

**REFIO:** Reference Voltage Input or Output. The 1.25V internal reference is available at the pin through a 10k internal resistor. May be overdriven with an external reference voltage between 1.1V and 1.4V.

**SCK:** Serial Interface Clock Input. Maximum frequency is 50MHz.

**SDI:** Serial Interface Data Input. Data on SDI is clocked in on the rising edge of SCK.

**SDO:** Serial Interface Data Output. Data is clocked out onto SDO by the falling edge of SCK. SDO is high impedance when  $\overline{CS}$  is high.

SV<sub>DD</sub>: SPI Supply Voltage Input. 1.71V to 3.465V.

**TSTP, TSTN:** Test Output Pins. May be optionally used to measure internal temperature or timing of LVDS inputs. See Measuring Internal Junction Temperature and Measuring LVDS Input Timing Skew sections in Applications Information. Use SPI internal registers 0x18 and 0x19 to control TSTP/N. Connect to GND if not used.

**Note:** For pin locations, refer to the Pin Locations section of this data sheet.

### **BLOCK DIAGRAM**

![](_page_17_Figure_2.jpeg)

### TIMING DIAGRAMS

![](_page_18_Figure_2.jpeg)

### OPERATION

#### Introduction

The LTC2000A is a family of 2.7Gsps current steering DACs. Three resolutions (16-, 14-, 11-bit) are available in a 170-lead BGA package. The LTC2000A features high output bandwidth and output current, while maintaining a clean output spectrum with low spurs, making it ideal for generating high frequency or broadband signals. The LTC2000A output current is nominally 40mA and is a scaled (16x) replica of the current flowing out of the FSADJ pin (nominally 2.5mA). The high output current allows

flexibility in the output impedance, and the high FSADJ current and low scaling factor give excellent close-in phase noise performance.

The LTC2000A has two 16-, 14-, 11-bit wide LVDS or DHSTL-compatible parallel data input ports (DAP/N, DBP/N). Each data input port is capable of receiving two's complement data at up to 1.35Gbps using a double data rate (DDR) data input clock (DCKIP/N) at up to 675MHz. The DDR data input clock may be either in quadrature or in phase with the data arriving on the data input ports.

After incoming data is sampled by DCKIP/N, an internal multiplexer interleaves the data for resampling by the DAC sample clock (CKP/N). See Figures 4a and 4b. After a pipeline delay (latency) of up to 11 DAC sample clock cycles, the rising edges of CKP/N update the DAC code and a proportional differential output current is steered between the two outputs ( $I_{OUTP/N}$ ). Note it takes about 3ns (aperture delay) from the CKP/N rising edge that updates a DAC code to the actual  $I_{OUTP/N}$  transition for that DAC code.

An internal clock synchronizer monitors the incoming phase of DCKIP/N and chooses the appropriate phase for the multiplexer control signals to ensure that the data is sampled correctly by CKP/N. The LTC2000A also generates an LVDS clock output (DCKOP/N) by dividing the sample clock frequency to simplify clocking of the host FPGA or ASIC. Additional features such as pattern generation, LVDS loopout, and junction temperature sensing simplify system development and testing.

The serial peripheral interface (SPI) port allows configuration and read back of the internal registers which control the above functions.

### Dual-Port Mode

In dual-port mode, data is written to both ports A and B simultaneously and then subsequently interleaved inside the LTC2000A, allowing DAC output sampling rates of up to 2.7Gsps. Figures 4a and 4b show a simplified block diagram and sample waveforms for dual-port operation.

The LVDS data input ports A and B are sampled on both the falling and rising edges of the DDR data input clock (DCKIP/N) by four groups of flip-flops. The contents of these flip-flops are then interleaved by the 4:1 MUX and sampled by the DAC sample clock (CKP/N) at frequencies up to 2.7GHz, with data from port A (DAP/N) preceding data from port B (DBP/N) at the DAC output. Note that the sample clock (CKP/N) frequency is always four times the DDR data input clock (DCKIP/N) frequency in dual-port mode. For example, to use the DAC at 2.7Gsps, apply a 2.7GHz clock to CKP/N and a 675MHz clock to DCKIP/N and send data into both ports A and B (DAP/N, DBP/N) at 1.35Gsps per port.

Latency is defined as the delay from the DCKIP/N transition that samples a DAC code to the CKP/N rising transition which causes that sample to appear at the DAC output  $I_{OUTP/N}$ . In dual-port mode the latency from DAP/N to  $I_{OUTP/N}$  is 10 sample clock cycles and the latency from DBP/N to  $I_{OUTP/N}$  is 11 cycles, starting from the CKP/N rising edge that immediately follows the DCKIP/N transition that sampled the DAC code (Figure 4b).

#### Single-Port Mode

In single-port mode, data is written to port B (DBP/N) only, allowing DAC output sampling rates of up to 1.35Gsps. Figures 4c and 4d show a block diagram and sample waveforms representing single-port operation. Samples are written to port B (DBP/N) and sampled on both the falling and rising edges of the DDR data input clock (DCKIP/N) by two groups of flip-flops. The contents of these flip-flops are then interleaved into a single data stream by the 2:1 MUX and sampled by the DAC sample clock (CKP/N) at frequencies up to 1.35GHz.

Note that in single-port mode the sample clock (CKP/N) frequency is always twice the DDR data input clock (DCKIP/N) frequency. For example, to use the DAC at 1.35Gsps, apply a 1.35GHz clock to CKP/N and a 675MHz clock to DCKIP/N and send data into port B (DBP/N) at 1.35Gsps. In singleport mode, port A (DAP/N) should be grounded. Due to the design of the internal clock synchronizer in single port mode, there is a half cycle shift in the single port latency. The latency from DBP/N to  $I_{OUTP/N}$  in single-port mode is 7.5 sample clock cycles, starting from the CKP/N falling edge that immediately follows the DCKIP/N transition that sampled the DAC code (Figure 4d).

![](_page_20_Figure_2.jpeg)

Figure 4a. Simplified Block Diagram – Dual-Port Operation

![](_page_20_Figure_4.jpeg)

Figure 4b. Sample Waveforms - Dual-Port Operation

### LTC2000A

### OPERATION

![](_page_21_Figure_2.jpeg)

Figure 4c. Simplified Block Diagram – Single-Port Operation

![](_page_21_Figure_4.jpeg)

Figure 4d. Sample Waveforms - Single-Port Operation

#### Serial Peripheral Interface (SPI)

The LTC2000A uses an SPI/MICROWIRE-compatible 3-wire serial interface to configure and read back internal registers. The SV<sub>DD</sub> pin is the power supply for the SPI interface (nominally 1.8V or 3.3V). The  $\overline{CS}$  input is level triggered. When this input is taken low, it acts as a chipselect signal, enabling the SDI and SCK buffers and the SPI input register. After the falling edge of  $\overline{CS}$ , the first data byte clocked into SDI by the rising edges of SCK is the command byte. The first bit of the command byte signifies a read (R/W = 1) or write (R/W = 0) operation. The next seven bits contain the register address, which completes the command byte.

The next byte transferred after the command byte is the data byte. For write operations, the data byte is written to the SPI register specified by the register address set in the command byte. During read operations, the data byte is ignored, and the contents of the selected SPI register are clocked out onto the SDO pin by the falling edges of SCK. During write operations, SDO will be low. When CS goes high, SDO is high impedance. Figure 5 shows the SPI command and data input.

Users wishing to transfer multiple bytes of data at once may do so, with the address for each subsequent byte automatically incremented internally. The address will continue to increment until  $\overline{CS}$  goes high or until address bits A[4:0] reach 0x1F, after which subsequent bytes will continue to be written to the same address.

Reserved address and bit locations should not be written with any value other than zero. Table 11 contains a full description of all internal SPI registers and can be found in the SPI Register Summary section.

#### **Power-On Reset**

The internal power-on reset circuit will reset the LTC2000A upon power up and clear the output to mid-scale when power is first applied, making system initialization consistent and repeatable. All internal registers are reset to 0x00, with the exception of register address 0x08, which resets to 0x08. A software reset can also be applied by using the SPI interface to load 0x01 into register address 0x01, setting SW\_RST to 1 (see Table 1). Note that the SW\_RST bit is automatically cleared when CS returns high. It is recommended that users perform a software reset once all power supplies are stable.

#### **Power Down**

Users wishing to save power when the DAC is not being used may reduce the supply current to less than 440 $\mu$ A by pulling the PD pin to GND or by writing to register 0x01 to set FULL\_PD = 1. Alternatively, users may power down unused portions of the chip individually using DAC\_PD, CK\_PD, DCKO\_DIS, DCKI\_EN, DA\_EN, and DB\_EN in registers 0x01, 0x02, 0x03, and 0x04 (see Table 1).

#### **Reference Operation**

The LTC2000A has a 1.25V internal bandgap voltage reference that drives the REFIO pin through a 10k internal resistor, and should be buffered if driving any additional external load. For noise performance, a  $0.1\mu$ F capacitor to GND is recommended on the REFIO pin, but is not required for stability.

In the case where an external reference would be preferred, the external reference is simply applied to the REFIO pin and overdrives the internal reference. The acceptable external reference range is 1.1V to 1.4V.

![](_page_22_Figure_14.jpeg)

Figure 5. SPI Command and Data Input

| Table 1. Tower-On Reset and Tower-Down Of Theyisters |
|--|
|--|

| ADDRESS | BIT | NAME     | DESCRIPTION   |
|---------|-----|----------|---|
| 0x01    | 0   | SW_RST   | Software Reset. Set SW_RST = 1 to restore all registers to their power-on reset state. SW_RST is automatically cleared when CS returns high. All registers reset to 0x00, except address 0x08 which resets to 0x08. |
|         | 1   | DAC_PD   | DAC Power Down. Set DAC_PD = 1 to power down the DAC and FSADJ bias circuits.   |
|         | 2   | FULL_PD  | Full Power Down. Set FULL_PD = 1 to power down all active circuits on the chip and reduce the supply current to less than $100\mu$ A.   |
| 0x02    | 0   | CK_PD    | CKP/N Clock Receiver Power Down. CKP/N clock receiver is powered down when CK_PD = 1.   |
|         | 4   | DCKO_DIS | DCKOP/N Output Disable. Set DCKO_DIS = 1 to power down the DCKO LVDS transmitter. For DCKO_DIS = 1, DCKOP/N are high impedance.   |
| 0x03    | 0   | DCKI_EN  | DCKIP/N Clock Receiver Enable. Set DCKI_EN = 1 to enable the DCKI clock receiver.   |
| 0x04    | 0   | DA_EN    | DAC Data Port A LVDS Receiver Enable. Set DA_EN = 1 to enable port A (DAP/N) LVDS receivers. For DA_EN = 0, port A LVDS receivers are powered down and port A data will be zeroes.                                  |
|         | 1   | DB_EN    | DAC Data Port B LVDS Receiver Enable. Set DB_EN = 1 to enable port B (DBP/N) LVDS receivers. For DB_EN = 0, port B LVDS receivers are powered down and port B data will be zeroes.                                  |

Note: Registers 0x01 to 0x04 reset to 0x00 (default).

#### Setting the Full-Scale Current

The full-scale DAC output current ( $I_{OUTFS}$ ) is nominally 40mA, but can be adjusted as low as 10mA or as high as 60mA. The full-scale current is set by placing an external resistor ( $R_{FSADJ}$ ) between the FSADJ pin and GND. An internal reference control loop amplifier sets the current flowing through  $R_{FSADJ}$  such that the voltage at FSADJ is equal to the voltage at REFIO, which is typically 1.25V.  $I_{OUTFS}$  is set as a scaled replica of the current flowing out of the FSADJ pin ( $I_{FSADJ}$ ):

$$I_{FSADJ} = \frac{V_{REFIO}}{R_{FSADJ}}$$
$$I_{OUTFS} = 16 \bullet I_{FSADJ} \bullet \frac{256}{256 + GAIN}$$

where GAIN\_ADJ is a 6-bit two's complement number from -32 to 31 (nominally 0) which can be programmed using SPI register 0x09 as shown in Table 2. For example, for  $R_{FSADJ} = 500\Omega$ ,  $V_{REFIO} = 1.25V$ , and GAIN\_ADJ = 0x00, the control loop will force 1.25V at the FSADJ pin, causing 2.5mA to flow through  $R_{FSADJ}$ .  $I_{OUTFS}$  will then be set to 16 • 2.5mA = 40mA.

Changing GAIN\_ADJ to 0x1F (+31) will decrease the current by 10.8% to 35.7mA. Changing GAIN\_ADJ to 0x20 (-32) will increase the current by 14.3% to 45.7mA.

Note that GAIN\_ADJ appears in the denominator of the equation for  $I_{OUTFS}$ , so the adjustment resolution varies from 0.5% to 0.3% per step. The circuit shown in Figure 6 may be used to vary the full-scale output current beyond the range of the GAIN\_ADJ register.

DAC linearity and harmonic distortion may be degraded when using full-scale currents other than 40mA. The fullscale current must not exceed 60mA, and is recommended to be at least 10mA.

![](_page_23_Figure_12.jpeg)

Figure 6. LTC2000A Full-Scale Adjust from 20mA to 60mA

| Table 2. | <b>Full-Scale</b> | Gain Ad | justment |
|----------|-------------------|---------|----------|
|----------|-------------------|---------|----------|

| ADDRESS | BIT   | NAME     | DESCRIPTION    |                    |                 |  |  |  |
|---------|-------|----------|----------------|--------------------|-----------------|--|--|--|
| 0x09    | [5:0] | GAIN_ADJ | GAIN_ADJ (HEX) | GAIN_ADJ (DECIMAL) | GAIN ADJUSTMENT | FULL-SCALE CURRENT ( $R_{FSADJ} = 500\Omega$ , $V_{REFI0} = 1.25V$ ) |  |  |
|         |       |          | 0x1F           | +31                | 89.2%           | 35.68mA  |  |  |
|         |       |          | 0x1E           | +30                | 89.5%           | 35.80mA  |  |  |
|         |       |          | —              | —                  | —               | —  |  |  |
|         |       |          | 0x01           | +1                 | 99.6%           | 39.84mA  |  |  |
|         |       |          | 0x00           | 0                  | 100.0%          | 40.00mA  |  |  |
|         |       |          | 0x3F           | -1                 | 100.4%          | 40.16mA  |  |  |
|         |       |          |                | —                  | —               | —  |  |  |
|         |       |          | 0x21           | -31                | 113.8%          | 45.51mA  |  |  |
|         |       |          | 0x20           | -32                | 114.3%          | 45.71mA  |  |  |

Note: Register 0x09 resets to 0x00 (default).

#### **DAC Transfer Function**

The LTC2000A contains an array of current sources that are steered through differential switches to either  $I_{OUTP}$  or  $I_{OUTN}$ , depending on the DAC code programmed through the LVDS parallel interface. The LTC2000A uses a 16-/14-/11-bit two's complement DAC code. The complementary current outputs,  $I_{OUTP}$  and  $I_{OUTN}$ , source current from 0mA to  $I_{OUTFS}$ . For  $I_{OUTFS} = 40$ mA (nominal),  $I_{OUTP}$  swings from 0mA (for zero-scale DAC code) to 40mA (for full-scale DAC code).  $I_{OUTN}$  is complementary to  $I_{OUTP}$ . When the DAC code is set to mid-scale (all zeros),  $I_{OUTFS}$  is evenly divided between  $I_{OUTP}$  and  $I_{OUTN}$ .  $I_{OUTP}$  and  $I_{OUTN}$  are given by the following formulas:

#### LTC2000A-16:

 $I_{OUTP} = I_{OUTFS} \bullet (CODE + 32768)/65536 + I_{OUTCM}$  $I_{OUTN} = I_{OUTFS} \bullet (32768 - CODE - 1)/65536 + I_{OUTCM}$ 

#### LTC2000A-14:

 $I_{OUTP} = I_{OUTFS} \bullet (CODE + 8192)/16384 + I_{OUTCM}$ 

 $I_{OUTN} = I_{OUTFS} \bullet (8192 - CODE - 1/4)/16384 + I_{OUTCM}$ 

#### LTC2000A-11:

 $I_{OUTP} = I_{OUTFS} \bullet (CODE + 1024)/2048 + I_{OUTCM}$ 

 $I_{OUTN} = I_{OUTFS} \bullet (1024 - CODE - 1/32)/2048 + I_{OUTCM}$ The DAC code ranges from  $-2^{N-1}$  to  $2^{N-1} - 1$ , with N being the DAC resolution (16/14/11).  $I_{OUTCM}$  is a small, constant common-mode output current that is equal to approximately 0.2% full-scale, or 80µA for  $I_{OUTFS} = 40$ mA. The LTC2000A differential output currents typically drive a resistive load either directly or drive an equivalent resistive load through a transformer (see the Output Configurations section). The voltage outputs generated by the  $I_{OUTP}$  and  $I_{OUTN}$  outputs currents are then:

Substituting the values above gives:

LTC2000A-16:

 $V_{DIFF} = V_{REFI0} \bullet (R_{LOAD}/R_{FSADJ}) \bullet (2 \bullet CODE + 1)/4096$ 

LTC2000A-14:

 $V_{DIFF} = V_{REFI0} \bullet (R_{LOAD}/R_{FSADJ}) \bullet (2 \bullet CODE + 1/4)/1024$ 

LTC2000A-11:

 $V_{DIFF} = V_{REFIO} \bullet (R_{LOAD}/R_{FSADJ}) \bullet (2 \bullet CODE + 1/32)/128$ 

Note that the gain of the DAC depends on the ratio of  $R_{LOAD}$  to  $R_{FSADJ}$ , and the gain error tempco is affected by the temperature tracking of  $R_{LOAD}$  with  $R_{FSADJ}$ .

### Analog Outputs (I<sub>OUTP/N</sub>)

The two complementary analog outputs ( $I_{OUTP/N}$ ) have low output capacitance that, with appropriate  $R_{LOAD}$  values, can achieve high output bandwidths of 2.1GHz. The analog outputs also have an internal impedance of 50 $\Omega$  to GND that will affect the calculation of  $R_{LOAD}$  and the output

voltage swing of the DAC. For example, loading both  $I_{OUTP}$  and  $I_{OUTN}$  with external 50 $\Omega$  resistors to GND will cause  $R_{LOAD}$  to equal 25 $\Omega$ . Assuming an  $I_{OUTFS}$  of 40mA,  $V_{DIFF}$  will swing between 1V and -1V.

The specified output compliance voltage range is  $\pm 1V$ . Above 1V, the differential current steering switches will start to approach the transition from saturation to linear region and degrade DAC linearity. Below -1V protection diodes will limit the swing of the DAC. Small voltage swings and low common-mode voltages typically result in the best distortion performance.

#### DAC Sample Clock (CKP/N)

The DAC sample clock (CKP/N) is used to update the LTC2000A outputs at rates of up to 2.7Gsps. Provide a clean, low jitter differential clock at up to 2.7GHz on pins CKP/N (see Generating the DAC Sample Clock section). The DC bias point of CKP/N is set internally through a 5k $\Omega$  impedance. A 0dBm DAC sample clock should be sufficient to obtain the performance shown in the Typical Performance Characteristics section. For best jitter and phase noise, AC couple a differential clock onto CKP/N with balanced duty cycle and the highest possible amplitude and slew rate.

Use SPI register 0x02 to control the DAC sample clock receiver (Table 3). The LTC2000A contains a clock detector which sets CK\_OK = 1 if the DAC sample clock is present and  $f_{DAC} > 50$ MHz. When the sample clock is not present (CK\_OK = 0), the DAC output is forced to mid-scale and the internal data path is held at reset. Set CK\_PD = 1 to

power down the clock receiver and save power when the DAC is not being used. Note that at power-on reset, the DAC sample clock receiver is on by default.

#### Divided Clock Output (DCKOP/N)

The LTC2000A contains a programmable clock divider and LVDS transmitter which provide a divided version (either  $f_{DAC}/4$  or  $f_{DAC}/2$ ) of the DAC sample clock for use by the host FPGA or ASIC. Use SPI register 0x02 to control DCKOP/N (Table 3). At power-on reset, the LVDS transmitter will provide a clock signal at  $f_{DAC}/4$  with a 3.5mA differential output current.

If desired, set DCKO\_DIV = 1 to change the divided clock output frequency to  $f_{DAC}/2$ . The output current can be increased to 7mA by setting DCKO\_ISEL = 1, and an internal 100 $\Omega$  differential termination can be enabled by setting DCKO\_TRM = 1. Set DCKO\_DIS = 1 to disable the LVDS transmitter and save power when not in use.

### LVDS Data Clock Input (DCKIP/N)

The DAC code data written to the LTC2000A is captured on both the rising and falling edges of DCKIP/N. For single-port operation, provide a DDR clock at half the DAC sample clock frequency ( $f_{DCKI} = f_{DAC}/2$ ). To use a 1.35GHz sample clock in single-port mode, provide a 675MHz clock on DCKIP/N. For dual-port operation, provide a DDR clock at one quarter the DAC sample clock frequency ( $f_{DCKI} = f_{DAC}/4$ ). To use a 2.7GHz sample clock in dual-port mode, provide a 675MHz clock on DCKIP/N.

| ADDRESS | BIT | NAME      | DESCRIPTION  |
|---------|-----|-----------|--|
| 0x02    | 0   | CK_PD     | CKP/N Clock Receiver Power Down When CK_PD = 1   |
|         | 1   | CK_OK     | CKP/N Clock Present Indicator. When CK_OK = 1, clock is present at CKP/N pins and $f_{DAC} > 50$ MHz. When CK_OK = 0, DAC output is forced to mid-scale. CK_OK is read only. |
|         | 4   | DCKO_DIS  | DCKOP/N Output Disable. Set DCKO_DIS = 1 to power down the DCKO LVDS transmitter. For DCKO_DIS = 1, DCKOP/N are high impedance.  |
|         | 5   | DCKO_DIV  | DCKOP/N Divide Select. When DCKO_DIV = 0, $f_{DCKOP/N} = f_{DAC}/4$ . When DCKO_DIV = 1, $f_{DCKOP/N} = f_{DAC}/2$ .   |
|         | 6   | DCKO_ISEL | DCKOP/N Output Current Select. When DCKO_ISEL = 0, output current is 3.5mA. When DCKO_ISEL = 1, output current is 7mA.   |
|         | 7   | DCKO_TRM  | DCKOP/N Internal Termination On. When DCKO_TRM = 0, there is no internal termination at DCKOP/N. When DCKO_TRM = 1, there is $100\Omega$ between DCKOP and DCKON.            |

Note: Register 0x02 resets to 0x00 (default).

| ADDRESS | BIT                     | NAME          | DESCRIPTION  |   |       |  |  |  |  |  |
|---------|-------------------------|---------------|--|---|-------|--|--|--|--|--|
| 0x03    | 0                       | DCKI_EN       | DCKIP/N Clock Receiver Enable. DCKI_   | DCKIP/N Clock Receiver Enable. DCKI_EN = 1 enables LVDS clock receiver.   |       |  |  |  |  |  |
|         | 1                       | DCKI_OK       | DCKIP/N Clock Present Indicator. Wher<br>When DCKI_OK = 0, DAC output is forc<br>DCKI_OK is read only.   | CKIP/N Clock Present Indicator. When DCKI_OK = 1, clock is present at DCKIP/N pins and f <sub>DCKIP/N</sub> > 25MHz.<br>When DCKI_OK = 0, DAC output is forced to mid-scale unless pattern generator is enabled (PGEN_EN = 1).<br>DCKI_OK is read only. |       |  |  |  |  |  |
|         | 2                       | DCKI_Q        | DCKIP/N Quadrature Phase Select. For<br>Set DCKI_Q = 1 to use DCKIP/N in quad  | CKIP/N Quadrature Phase Select. For DCKI_Q = 0, DCKIP/N should be in phase with DAP/N and DBP/N.<br>Set DCKI_Q = 1 to use DCKIP/N in quadrature with DAP/N and DBP/N.   |       |  |  |  |  |  |
|         | [6:4]                   | DCKI_TADJ     | DCKIP/N Delay Adjust. Use with DCKI_Q = 0 to adjust delay of DCKIP/N relative to DAP/N and DBP/N.<br>For DCKI_Q = 1, DCKIP/N delay matches DAP/N and DBP/N and is unaffected by DCKI_TADJ. |   |       |  |  |  |  |  |
|         |                         |               | NOMINAL DCKIP/N DELAY  |   |       |  |  |  |  |  |
|         |                         |               | DCKI_TADJ DCKI_Q = 1 DCKI_Q = 0  |   |       |  |  |  |  |  |
| 110 Ops |                         |               |  |   | 230ps |  |  |  |  |  |
|         | 315ps                   |               |  |   |       |  |  |  |  |  |
|         | 000 Ops 400ps (Default) |               |  |   |       |  |  |  |  |  |
|         |                         | 001 0ps 485ps |  |   |       |  |  |  |  |  |
|         |                         |               | Ops  | 570ps   |       |  |  |  |  |  |

Table 4. LVDS Clock SPI Registers

Note: Register 0x03 resets to 0x00 (default).

Use SPI register 0x03 to control the LVDS data clock input (see Table 4). Setting DCKI EN=1 will enable the LVDS receiver at DCKIP/N. The LTC2000A contains a clock detector which sets DCKI OK=1 if the data input clock is present and has a frequency greater than 25 MHz ( $f_{DCKI} > 25$  MHz). When the data clock is not present (DCKI OK = 0), the DAC output is forced to mid-scale and the internal data path is held at reset.

For maximum setup/hold margin, set DCKI Q = 1 and provide DCKIP/N in guadrature (90° out of phase) with the data on DAP/N and DBP/N (Figure 3 in the Timing Diagrams section). For DCKI Q = 1, the internal delays on DCKIP/N, DAP/N, and DBP/N are nominally matched.

Alternatively, it is possible to leave DCKI Q = 0 and provide the clock at DCKIP/N in phase with the data on DAP/N and DBP/N (see Figure 2 of the Timing Diagram section). In this case, an internal 400ps delay on DCKIP/N is used to provide setup/hold margin. Note that for DCKI Q = 0. supply and temperature variation may reduce the setup/ hold margin on the bus by up to 150ps. If desired, users may use the DCKI TADJ bits in register 0x03 to adjust the 400ps internal DCKIP/N delay with a typical resolution of 85ps.

Board trace lengths on DCKIP/N, DAP/N, and DBP/N must be carefully matched to ensure that phase alignment is

maintained on all inputs. If desired during development, users may observe the relative timing of neighboring LVDS inputs on the TSTP/N pins (refer to the Measuring LVDS Input Timing Skew section).

#### LVDS Data Input Ports (DAP/N, DBP/N)

The LTC2000A-16/LTC2000A-14/LTC2000A-11 allow for DAC Code Data to be applied through one or two parallel 16-/14-/11-bit LVDS ports (DAP/N, DBP/N). Each port can run up to 1.35Gbps using a double-data-rate (DDR) LVDS data clock (DCKIP/N) at frequencies up to 675MHz. The data input format is two's complement.

There are two modes of operation for applying the DAC code to the LTC2000A - single-port mode and dualport mode. Single port operation uses only LVDS port B (DBP/N) and allows sample rates of up to 1.35Gsps. Dual port operation uses both LVDS ports (DAP/N and DBP/N) and allows sample rates up to 2.7Gsps.

Use SPI register 0x04 to control the LVDS data input ports (see Table 5). After the clocks have stabilized and the synchronizer has initialized itself, set DATA\_EN = 1 to allow the data from ports A and B to be used to update the DAC code. Clear DATA EN = 0 to mute the DAC and force the DAC code to mid-scale as desired.

#### Table 5. LVDS Data Input SPI Registers

| ADDRESS | BIT | NAME    | DESCRIPTION   |
|---------|-----|---------|---|
| 0x04    | 0   | DA_EN   | DAC Data Port A LVDS Receiver Enable. DA_EN = 1 enables port A receivers. For DA_EN = 0, receivers are powered down and port A data is 0x0000.  |
|         | 1   | DB_EN   | DAC Data Port B LVDS Receiver Enable. DB_EN = 1 enables port B receivers. For DB_EN = 0, receivers are powered down and port B data is 0x0000.  |
|         | 2   | DATA_SP | DAC Data Single Port Mode Select. DATA_SP = 1 sets single port mode and only port B data is used to update the DAC code. DATA_SP = 0 sets dual-port mode and data from both ports A and B are used. |
|         | 3   | DATA_EN | DAC Data Enable. DATA_EN = 0 mutes the DAC output by forcing the DAC code to mid-scale. DATA_EN = 1 allows data from data ports A and B to be used to update the DAC code.                          |

Note: Register 0x04 resets to 0x00 (default).

For single port operation, set DATA\_SP = 1, DA\_EN = 0, DB\_EN = 1 and provide data to LVDS port B (DBP/N) only. For dual port operation leave DATA\_SP = 0, set DA\_EN = 1 and DB\_EN = 1, and provide interleaved data to LVDS ports A and B (DAP/N, DBP/N). The data on port A will precede the data on port B at the DAC output.

#### **Clock Synchronizer**

Figure 7 shows a simplified block diagram of the internal clock synchronizer. The synchronizer monitors the incoming phase of DCKIP/N using a pair of internal phase comparators. The synchronizer then automatically adjusts the

![](_page_27_Figure_8.jpeg)

Figure 7. Simplified Block Diagram — Clock Synchronizer in Dual-Port Mode

phase of the MUX control signals as needed to track any slow drift in the phase between the DCKIP/N and CKP/N due to supply and temperature variation. This ensures that data is sampled correctly by CKP/N.

Use SPI registers 0x05 and 0x06 (Table 6) to observe and control the operation of the synchronizer. Upon power-up, apply clocks to CKP/N and DCKIP/N and set DCKI\_EN = 1 (register 0x03) to enable the LVDS data clock receiver. Allow at least 1ms after the clocks have stabilized for the synchronizer to initialize, after which the LTC2000A is ready to accept LVDS input data.

The synchronizer uses phase comparators to monitor the phase of the data input clock relative to the sample clock divider which controls the MUX. The outputs of these phase comparators (SYNC\_PH) may be observed in register 0x06.

The SYNC\_PS bits control the phase of the data multiplexer. For SYNC\_MSYN = 0, the SYNC\_PS bits are read-only and are automatically adjusted by the synchronizer as needed, based upon the phase of DCKIP/N indicated by SYNC\_PH.

Users may choose to override the automatic synchronizer by setting SYNC\_MSYN = 1 and writing values manually to SYNC\_PS to set the phase of the internal multiplexer. When using SYNC\_MSYN = 1, users must monitor SYNC\_PH and adjust SYNC\_PS as needed according to Table 6. For further details see the Synchronizing Multiple LTC2000As section.

| ADDRESS | BIT   | NAME      | DESCRIPTION  |                |                  |  |  |  |
|---------|-------|-----------|--|----------------|------------------|--|--|--|
| 0x05    | [1:0] | SYNC_PS   | Synchronizer Phase Select. Selects phase of internal data multiplexer. SYNC_PS is read-only when SYNC_MSYN = 0.  |                |                  |  |  |  |
|         | 2     | SYNC_MSYN | Synchronizer Manual Mode Select. When SYNC_MSYN = 0, SYNC_PS is set automatically by the clock synchronizer based upon SYNC_PH. When SYNC_MSYN = 1, SYNC_PS must be set by the user.                             |                |                  |  |  |  |
| 0x06    | [7:0] | SYNC_PH   | Synchronizer Phase Comparator Outputs. SYNC_PH indicates the phase of the LVDS data clock (DCKIP/N) relative to the DAC sample clock (CKP/N) divider used to control the data multiplexer. SYNC_PH is read only. |                |                  |  |  |  |
|         |       |           |  | OPTIMAL SYNG   | C_PS SETTING     |  |  |  |
|         |       |           | SYNC_PH  | DUAL-PORT MODE | SINGLE-PORT MODE |  |  |  |
|         |       |           | 0×03   | 10             | 00               |  |  |  |
|         |       |           | 0x04   | 10             | 00               |  |  |  |
|         |       |           | 0×05   | 10             | 00               |  |  |  |
|         |       |           | 0x15   | 10             | 00               |  |  |  |
|         |       |           | 0x25   | 10             | 00               |  |  |  |
|         |       |           | 0x35   | 00             | 10               |  |  |  |
|         |       |           | 0x45   | 00             | 10               |  |  |  |
|         |       |           | 0x55   | 00             | 10               |  |  |  |
|         |       |           | 0x54   | 00             | 10               |  |  |  |
|         |       |           | 0x53   | 00             | 10               |  |  |  |
|         |       |           | 0x52   | 01             | 10               |  |  |  |
|         |       |           | 0x51   | 01             | 10               |  |  |  |
|         |       |           | 0x50   | 01             | 10               |  |  |  |
|         |       |           | 0x40   | 01             | 10               |  |  |  |
|         |       |           | 0x30   | 01             | 10               |  |  |  |
|         |       |           | 0x20   | 11             | 00               |  |  |  |
|         |       |           | 0x10   | 11             | 00               |  |  |  |
|         |       |           | 0x00   | 11             | 00               |  |  |  |
|         |       |           | 0x01   | 11             | 00               |  |  |  |
|         |       |           | 0x02   | 11             | 00               |  |  |  |

#### Table 6. Clock Synchronizer SPI Registers

Note: Registers 0x05 and 0x06 reset to 0x00 (default).

#### Minimizing Harmonic Distortion

The LTC2000A contains proprietary dynamic linearization circuitry which dramatically reduces 3rd order harmonic distortion in the DAC output. SPI registers 0x07 and 0x08 are used to control these circuits (see Table 7). Optimal performance is normally achieved by setting LIN\_VMX and LIN\_VMN (register 0x08) to correspond to the maximum and minimum voltages expected at  $I_{OUTP/N}$ . At power-on reset the default values are 0b1000 and 0b0000, which are appropriate for  $I_{OUTP/N}$  swinging between 500mV and GND. If an application requires a different voltage swing, LIN\_VMX and LIN\_VMN can be programmed by writing to register 0x08 (see Table 7). For applications in which  $I_{OUTP/N}$  swing below GND, use LIN\_VMN = 0b0000.

In some applications where 2-tone intermodulation distortion (IMD) is a critical specification, it may be desired to vary the amount of 3rd order harmonic correction. For high sampling frequencies ( $f_{DAC} > 2Gsps$ ), adjusting LIN\_GN in register 0x07 (see Table 7) can improve 2-tone intermodulation distortion at the expense of higher 3rd order harmonic distortion. For best IMD performance at high sampling frequencies, users may also choose to disable dynamic linearization by setting LIN\_DIS = 1. SFDR and IMD curves in the Typical Performance Characteristics section show more detail regarding this effect. Note that for  $f_{DAC} < 2Gsps$ , it is recommended to leave the dynamic linearization enabled.

### Measuring LVDS Input Timing Skew

It is important to ensure that the LVDS inputs (DCKIP/N, DAP/N, DBP/N) are well aligned. Skew between clock and data lines, for example due to board trace length mismatch or output timing mismatch inside the host FPGA or ASIC, will degrade the setup and hold margin of the incoming data. The LTC2000A includes an internal test multiplexer which may be used during development to verify timing alignment by comparing the timing of LVDS inputs one pair at a time through the TSTP/N pins.

Use SPI register 0x18 to control this test multiplexer (see Table 8). Be sure TDIO\_EN = 0 in register 0x19 and then set LMX\_EN = 1 to enable the test multiplexer output. The signal from the LVDS data input will be driven onto TSTP/N by an NMOS differential pair steering a 6.6mA sink current onto an external load. Connect a pair of  $50\Omega$ 

resistors from TSTP/N to 3.3V and observe TSTP/N on a high speed oscilloscope.

Apply clocks to CKP/N and DCKIP/N and apply the pattern shown in Figure 8 to port B for single-port mode or ports A and B for dual-port mode. This pattern is designed to simplify comparison of rising-to-rising and falling-tofalling edge timing for each input pair. Set LMX\_ADR to select a pair of LVDS inputs for timing comparison. Set LMX\_MSEL = 0 to observe the first signal at TSTP/N. Set LMX\_MSEL = 1 to observe the second signal with inverted output polarity.

For example, to compare DB15P/N to DCKIP/N, first write 0x60 to register 0x18 to set LMX\_EN = 1, LMX\_ADR = 10000, and LMX\_SEL = 0. The signal from DB15P/N will be driven onto TSTP/N. Write 0x61 to register 0x18 to set LMX\_SEL = 1 and cause DCKIP/N to appear at TSTP/N with inverted polarity.

Record the skew between the two signals and repeat this measurement for each pair of inputs. After all pairs have been measured, add the skews to calculate the total skew from DCKIP/N to each data input (DAP/N, DBP/N). In this way the skew of all LVDS data inputs (DAP/N, DBP/N) relative to DCKIP/N can be accurately measured to within 100ps.

Note that due to internal delays inside the test multiplexer, it is only valid to compare timing between neighboring LVDS pairs using the same LMX\_ADR setting. Similarly, the multiplexer itself contains up to 400ps of skew between rising and falling edges, so it is only valid to compare the timing of a rising edge at TSTP/N to another rising edge, and a falling edge to another falling edge.

Note that Figure 8 shows the suggested input pattern for the LTC2000A-16. LTC2000A-14 users should apply codes 0x1555 and 0x2AAA, and LTC2000A-11 users should apply codes 0x555 and 0x2AA. Also note that for the LTC2000A-14 and LTC2000A-11 in dual-port mode, the timing skew of LVDS port A (DAP/N) cannot be compared to that of the LVDS clock (DCKIP/N) and LVDS port B (DBP/N), as there is no single test multiplexer address (LMX\_ADR) that enables a timing comparison between signals DA0N/P and DCKIP/N (see Table 8). It is recommended to keep LMX\_EN = 0 during normal operation.

| Table 7. | Dynamic I | Linearization | SPI | Registers |
|----------|-----------|---------------|-----|-----------|
|----------|-----------|---------------|-----|-----------|

| ADDRESS | BIT   | NAME    | DESCRIPTION  |   |  |  |  |  |
|---------|-------|---------|--|---|--|--|--|--|
| 0x07    | 0     | LIN_DIS | Dynamic Linearizat   | ion Disable. Disabled when LIN_DIS = 1. |  |  |  |  |
|         | [3:1] | LIN_GN  | Dynamic Linearization Gain Select. Changing LIN_GN varies the amount of 3rd order harmonic correction applied DAC output. LIN_GN = 000 is normally optimal.  |   |  |  |  |  |
|         |       |         | LIN_GN   | LINEARIZATION PERCENTAGE                |  |  |  |  |
|         |       |         | 110  | 50%                                     |  |  |  |  |
|         |       |         | 111  | 63%                                     |  |  |  |  |
|         |       |         | 000  | 75% (default)                           |  |  |  |  |
|         |       |         | 001  | 88%                                     |  |  |  |  |
|         |       |         | 010  | 100%                                    |  |  |  |  |
|         |       |         | 011  | 113%                                    |  |  |  |  |
|         |       |         | 100  | 125%                                    |  |  |  |  |
|         |       |         | 101  | 138%                                    |  |  |  |  |
| 0x08    | [3:0] | LIN_VMX | Dynamic Linearization Max $I_{OUTP/N}$ Voltage Select. For optimal 3rd order harmonic performance, set LIN_VMX to correspond to the maximum voltage expected at $I_{OUTP/N}$ . Reset state is LIN_VMX = 1000, which corresponds to 0.51V. LIN_VMX must be greater than LN_VMN.           |   |  |  |  |  |
|         | [7:4] | LIN_VMN | Dynamic Linearization Min I <sub>OUTP/N</sub> Voltage Select. For optimal 3rd order harmonic performance, set LIN_VMN to correspond to the minimum voltage expected at I <sub>OUTP/N</sub> . Reset state is LIN_VMN = 0000, which corresponds to 0.0V. LIN_VMN must be less than LN_VMX. |   |  |  |  |  |
|         |       |         | LIN_VMX/N  | MAX/MIN VOLTAGE EXPECTED AT IOUTP/N     |  |  |  |  |
|         |       |         | 0000   | 0.00V (Default for LIN_VMN)             |  |  |  |  |
|         |       |         | 0001   | 0.16V                                   |  |  |  |  |
|         |       |         | 0010   | 0.19V                                   |  |  |  |  |
|         |       |         | 0011   | 0.22V                                   |  |  |  |  |
|         |       |         | 0100   | 0.25V                                   |  |  |  |  |
|         |       |         | 0101   | 0.31V                                   |  |  |  |  |
|         |       |         | 0110   | 0.38V                                   |  |  |  |  |
|         |       |         | 0111   | 0.44V                                   |  |  |  |  |
|         |       |         | 1000   | 0.51V (Default for LIN_VMX)             |  |  |  |  |
|         |       |         | 1001   | 0.63V                                   |  |  |  |  |
|         |       |         | 1010   | 0.75V                                   |  |  |  |  |
|         |       |         | 1011   | 0.87V                                   |  |  |  |  |
|         |       |         | 1100   | 1.00V                                   |  |  |  |  |

Note: Register 0x07 resets to 0x00 (default). Register 0x08 resets to 0x08 (default).

#### Table 8. SPI Registers for Measuring LVDS Input Timing Skew

| ADDRESS | BIT   | NAME     | DESCRIPTION   |
|---------|-------|----------|---|
| 0x18    | 0     | LMX_MSEL | LVDS Test MUX Select. Set LMX_MSEL high or low to select between a pair of neighboring LVDS signals for comparison at TSTP/N. |
|         | [5:1] | LMX_ADR  | LVDS Test MUX Address. Use LMX_ADR to select which pair of LVDS signals will be compared at TSTP/N (See Below).               |
|         | 6     | LMX_EN   | LVDS Test MUX Enable. Set LMX_EN=1 to compare timing of neighboring signals at TSTP/N.<br>Ensure TDIO_EN = 0 when LMX_EN = 1. |

| LMX_ADR    | LTC20        | DOA-16                     | LTC20        | 00A-14                     | LTC2000A-11  |                            |  |
|------------|--------------|----------------------------|--------------|----------------------------|--------------|----------------------------|--|
|            | LMX_MSEL = 0 | LMX_MSEL = 1<br>(INVERTED) | LMX_MSEL = 0 | LMX_MSEL = 1<br>(INVERTED) | LMX_MSEL = 0 | LMX_MSEL = 1<br>(INVERTED) |  |
| 00000      | DA14P/N      | DA15N/P                    | DA12P/N      | DA13N/P                    | DA9P/N       | DA10N/P                    |  |
| 0000101001 | DA[13:5]P/N  | DA[14:6]N/P                | DA[11:3]P/N  | DA[12:4]N/P                | DA[8:0]P/N   | DA[9:1]N/P                 |  |
| 01010      | DA4P/N       | DA5N/P                     | DA2P/N       | DA3N/P                     | —            | DA0N/P                     |  |
| 01011      | DA3P/N       | DA4N/P                     | DA1P/N       | DA2N/P                     | —            | —                          |  |
| 01100      | DA2P/N       | DA3N/P                     | DA0P/N       | DA1N/P                     | —            | —                          |  |
| 01101      | DA1P/N       | DA2N/P                     | _            | DA0N/P                     | _            | _                          |  |
| 01110      | DA0P/N       | DA1N/P                     | —            |                            | —            | _                          |  |
| 01111      | DCKIP/N      | DA0N/P                     | DCKIP/N      | _                          | DCKIP/N      | _                          |  |
| 10000      | DB15P/N      | DCKIN/P                    | DB13P/N      | DCKIN/P                    | DB10P/N      | DCKIN/P                    |  |
| 10001      | DB14P/N      | DB15N/P                    | DB12P/N      | DB13N/P                    | DB9P/N       | DB10N/P                    |  |
| 1001011010 | DB[13:5]P/N  | DB[14:6]N/P                | DB[11:3]P/N  | DB[12:4]N/P                | DB[8:0]P/N   | DB[9:1]N/P                 |  |
| 11011      | DB4P/N       | DB5N/P                     | DB2P/N       | DB3N/P                     | —            | DB0N/P                     |  |
| 11100      | DB3P/N       | DB4N/P                     | DB1P/N       | DB2N/P                     | —            | —                          |  |
| 11101      | DB2P/N       | DB3N/P                     | DB0P/N       | DB1N/P                     | —            | _                          |  |
| 11110      | DB1P/N       | DB2N/P                     | _            | DB0N/P                     | _            | _                          |  |
| 11111      | DB0P/N       | DB1N/P                     | —            | —                          | —            | —                          |  |

Note: Register 0x18 resets to 0x00 (default).

![](_page_31_Figure_6.jpeg)

![](_page_31_Figure_7.jpeg)

#### Measuring Internal Junction Temperature (T<sub>J</sub>)

The LTC2000A test multiplexer may also be used to connect internal junction temperature measurement diodes to the TSTP/N pins. Ensure LMX\_EN = 0 (register address 0x18) and use SPI register 0x19 to set TDIO\_EN = 1 to enable this function (Table 9). There are two methods the user can choose from to measure internal junction temperature (T<sub>J</sub>). For TDIO\_SEL = 0, an unbiased NPN transistor is diode-connected between the TSTP/N pins with a series resistance of approximately  $350\Omega$ . This diode is suitable for use with external temperature sensors which offer series resistance cancellation such as the LTC2991 or LTC2997.

If such a temperature sensor is not available, set TDIO\_SEL = 1 to directly observe a temperature dependent voltage between TSTP and TSTN. The typical expected voltage at TSTP is  $V_{TSTP} = 2.02V - 5.5mV/^{\circ}C \cdot (T_J - 25^{\circ}C)$ . The junction temperature can be calculated as  $T_J = 25^{\circ}C + (2.02V - V_{TSTP})/(5.5mV/^{\circ}C)$ . For best accuracy with TDIO\_SEL = 1, use TSTN to sense GND at the bottom of the diode and calibrate the voltage at a known temperature. Typical uncalibrated accuracy is  $\pm 5^{\circ}C$ .

#### **Pattern Generator**

A 64 sample deep pattern generator is included in the LTC2000A to simplify system development and debug. The pattern generator allows the user to send a repeating 64 sample pattern to the DAC, completely independent of the presence or absence of valid signals on DCKIP/N, DAP/N, and DBP/N.

Table 9. Internal Junction Temperature SPI Registers

To use this feature, do the following:

- 1. Set DCKO\_DIV = 0 in register 0x02, DATA\_SP = 0 and DATA\_EN = 0 in register 0x04, and PGEN\_EN = 0 in register 0x1E.
- 2. Write 128 bytes of pattern data to address 0x1F (PGEN\_D) to fill the pattern generator with 64 samples. Data is written MSB first, and will be applied to the DAC in the order written. Data may be written one byte at a time or in larger multi-byte words. For the LTC2000A-14 and LTC2000A-11, data should be left justified with zeros filling the remaining two (LTC2000A-14) or five (LTC2000A-11) bits.
- 3. Set PGEN\_EN = 1 to start the pattern generator.
- 4. Wait at least 1ms to ensure that the synchronizer has initialized.
- 5. Set DATA\_EN = 1 in register 0x04. The DAC will then begin to output the 64 sample pattern.

The pattern generator will send the repeating 64 sample pattern to the DAC until the user writes  $PGEN_EN = 0$  or  $DATA_EN = 0$ .

To read back the pattern, set DATA\_EN = 0 and PGEN\_EN = 0 and then read 128 bytes from address 0x1F. Note that the starting point of the pattern may have changed while the pattern was running. To modify the pattern, set DATA\_EN = 0 and PGEN\_EN = 0 and write a new 64 sample pattern to address 0x1F. Ensure PGEN\_EN = 0 when reading or writing to address 0x1F, and always read or write an entire 64 sample pattern prior to setting PGEN\_EN = 1. See Table 10.

| ADDRESS | BIT | NAME     | DESCRIPTION   |
|---------|-----|----------|---|
| 0x19    | 0   | TDIO_EN  | TSTP/N Junction Temperature Diode Enable. Set TDIO_EN = 1 to measure internal junction temperature ( $T_J$ ) at TSTP/N. Ensure LMX_EN = 0 when TDIO_EN = 1.   |
|         | 1   | TDIO_SEL | Selects which internal temperature diode is observable at TSTP/N.   |
|         |     |          | For TDIO_SEL = 1, the typical voltage at TSTP with respect to TSTN is $V_{TSTP} = 2.02V - 5.5mV/^{\circ}C \cdot (T_J - 25^{\circ}C)$ .<br>Junction temperature can be calculated as $T_J = 25^{\circ}C + (2.02V - V_{TSTP})/(5.5mV/^{\circ}C)$ . Typical accuracy is $\pm 5^{\circ}C$ . |
|         |     |          | For TDIO_SEL = 0, an unbiased diode is connected b/w TSTP/N for use with external temperature sensors.  |

Note: Register 0x19 resets to 0x00 (default).

|               |       | in aonorator | or r noglotoro  |
|---------------|-------|--------------|---|
| ADDRESS       | BIT   | NAME         | DESCRIPTION   |
| 0x1E          | 0     | PGEN_EN      | Pattern Generator Enable. Set PGEN_EN = 1 to use the internal 64 sample pattern generator to provide data to the DAC. Set DATA_SP = 0, DCKO_DIV = 0, and DATA_EN = 1 when PGEN_EN = 1.  |
| 0x1F          | [7:0] | PGEN_D       | Pattern Generator Data. Write 128 bytes of data to this address to fill the pattern generator with 64 samples.<br>Data is written MSB first. Reading this location causes the pattern generator data to be shifted out through SDO.<br>Ensure PGEN_EN = 0 when reading or writing to address 0x1F. Read or write an even number of bytes to address<br>0x1F prior to setting PGEN_EN = 1 to avoid corrupting the data inside the pattern generator. |
| Mater Desited | A     |              |   |

Note: Registers 0x1E and 0x1F reset to 0x00 (default).

### **SPI REGISTER SUMMARY**

#### Table 11. SPI Register List

| ADDRESS | BIT   | NAME      | DESCRIPTION   | RESET<br>VALUE             | R/W |
|---------|-------|-----------|---|----------------------------|-----|
| 0x00    | [7:0] | Reserved  | Reserved  |                            |     |
| 0x01    | 0     | SW_RST    | Software Reset. SW_RST = 1 resets all registers.  | 0                          | R/W |
|         | 1     | DAC_PD    | DAC Power Down. DAC_PD = 1 to power down DAC core.  | 0                          | R/W |
|         | 2     | FULL_PD   | Full Power Down. FULL_PD = 1 to power down LTC2000A.  | 0                          | R/W |
|         | 3     | Reserved  | Reserved  |                            |     |
|         | [5:4] | DAC_RES   | DAC Resolution Indicator. DAC_RES = 00 for LTC2000A-16. DAC_RES = 01 for LTC2000A-14. DAC_RES = 11 for LTC2000A-11. Note that for $\overline{PD}$ = GND or FULL_PD = 1, DAC_RES = 00. DAC_RES is read only. | 00-16b<br>01-14b<br>11-11b | R   |
|         | [7:6] | Reserved  | Reserved  |                            |     |
| 0x02    | 0     | CK_PD     | CKP/N Clock Receiver Power Down. CK_PD = 1 disables   | 0                          | R/W |
|         | 1     | CK_OK     | CKP/N Clock Present Indicator. CK_OK = 1 clock present  | 0                          | R   |
|         | [3:2] | Reserved  | Reserved  |                            |     |
|         | 4     | DCKO_DIS  | DCKOP/N Output Disable. DCKO_DIS = 1 disables   | 0                          | R/W |
|         | 5     | DCK0_DIV  | DCKOP/N Divide Select. (0 = $f_{DAC}/4$ , 1 = $f_{DAC}/2$ ).  | 0                          | R/W |
|         | 6     | DCKO_ISEL | DCKOP/N Output Current Select. (0=3.5mA, 1 = 7mA)   | 0                          | R/W |
|         | 7     | DCKO_TRM  | DCKOP/N Internal Termination On. DCKO_TRM = 1 enables internal $100\Omega$ termination  | 0                          | R/W |
| 0x03    | 0     | DCKI_EN   | DCKIP/N Clock Receiver Enable. DCKI_EN = 1 enables.   | 0                          | R/W |
|         | 1     | DCKI_OK   | DCKIP/N Clock Present Indicator. DCKI_OK = 1 indicates clock present  | 0                          | R   |
|         | 2     | DCKI_Q    | DCKIP/N Quadrature Phase Select. (0 = In Phase, 1 = Quadrature)   | 0                          | R/W |
|         | 3     | Reserved  | Reserved  |                            |     |
|         | [6:4] | DCKI_TADJ | DCKIP/N Delay Adjust. (See Table 4)   | 000                        | R/W |
|         | 7     | Reserved  | Reserved  |                            |     |
| 0x04    | 0     | DA_EN     | Port A LVDS Receiver Enable. DA_EN = 1 enables  | 0                          | R/W |
|         | 1     | DB_EN     | Port B LVDS Receiver Enable. DB_EN = 1 enables  | 0                          | R/W |
|         | 2     | DATA_SP   | Port Mode Select. (0 = Dual port, 1 = Single port)  | 0                          | R/W |
|         | 3     | DATA_EN   | DAC Data Enable. DATA_EN = 0 forces DAC output to mid-scale.  | 0                          | R/W |
|         | [7:4] | Reserved  | Reserved  |                            |     |
| 0x05    | [1:0] | SYNC_PS   | Clock Synchronizer Phase Select.  | 00                         | R/W |
|         | 2     | SYNC_MSYN | Clock Synchronizer Manual Mode Select.  | 0                          | R/W |
|         |       |           | SYNC_MSYN = 0: SYNC_PS is set automatically.  |                            |     |
|         |       |           | SYNC_MSYN = 1: SYNC_PS is set by the user.  |                            |     |
|         | [7:3] | Reserved  | Reserved  |                            |     |
| 0x06    | [7:0] | SYNC_PH   | Clock Phase Comparator Outputs. (See Table 6)   | 0x00                       | R   |
| 0x07    | 0     | LIN_DIS   | Dynamic Linearization Disable. LIN_DIS = 1 disables.  | 0                          | R/W |
|         | [3:1] | LIN_GN    | Dynamic Linearization Gain Select. (See Table 7)  | 000                        | R/W |
|         | [7:4] | Reserved  | Reserved  |                            |     |
| 0x08    | [3:0] | LIN_VMX   | Dynamic Linearization Max I <sub>OUTP/N</sub> Voltage Select. (See Table 7)   | 1000                       | R/W |
|         | [7:4] | LIN_VMN   | Dynamic Linearization Min I <sub>OUTP/N</sub> Voltage Select. (See Table 7)   | 0000                       | R/W |

### SPI REGISTER SUMMARY

#### Table 11. SPI Register List (cont)

| ADDRESS           | BIT   | NAME     | DESCRIPTION  | RESET<br>VALUE | R/W |
|-------------------|-------|----------|--|----------------|-----|
| 0x09              | [5:0] | GAIN_ADJ | DAC Gain Adjustment. (See Table 2)   | 0x00           | R/W |
|                   | [7:6] | Reserved | Reserved   |                |     |
| 0x0A Thru<br>0x17 | [7:0] | Reserved | Reserved   |                |     |
| 0x18              | 0     | LMX_MSEL | LVDS Test MUX Select. (See Table 8)  | 0              | R/W |
|                   | [5:1] | LMX_ADR  | LVDS Test MUX Address Select. (See Table 8)  | 0x00           | R/W |
|                   | 6     | LMX_EN   | LVDS Test MUX Enable. LMX_EN = 1 enables LVDS text MUX. Ensure TDIO_EN = 0 when LMX_EN = 1.  |                |     |
|                   | 7     | Reserved | Reserved   |                |     |
| 0x19              | 0     | TDIO_EN  | TSTP/N Junction Temperature Diode Enable.<br>TDIO_EN = 1 enables temperature $(T_J)$ measurement.<br>Ensure LMX_EN = 0 when TDIO_EN = 1.   | 0              | R/W |
|                   | 1     | TDIO_SEL | Junction Temperature Select. TDIO_SEL = 0 uses a diode-connected unbiased NPN transistor.<br>TDIO_SEL = 1 outputs a voltage to calculate internal die temperature using:<br>$T_J = 25^{\circ}C + (2.02V - V_{TSTP})/(5.5mV/^{\circ}C)$ . (See Table 9) | 0              | R/W |
|                   | [7:2] | Reserved | Reserved   |                |     |
| 0x1A Thru<br>0x1D | [7:0] | Reserved | Reserved   |                |     |
| 0x1E              | 0     | PGEN_EN  | Pattern Generator Enable. PGEN_EN = 1 enables.   | 0              | R/W |
|                   | [7:1] | Reserved | Reserved   |                |     |
| 0x1F              | [7:0] | PGEN_D   | Pattern Generator Data.  | 0x00           | R/W |
| 0x20 Thru<br>0x7F | [7:0] | Reserved | Reserved   |                |     |

### **APPLICATIONS INFORMATION**

#### Sample Start-Up Sequence

The following is an example of a common start-up sequence.

- 1. Apply valid supply voltages to AV\_{DD33}, DV\_{DD33}, AV\_{DD18}, D\_{VDD18} and SV\_DD.
- 2. Write 0x01 to address 0x01 to perform a software reset.
- 3. Apply a clock to CKP/N at the desired  $f_{DAC}$  frequency. The LTC2000A will generate a clock at DCKOP/N at  $f_{DAC}/4.$
- 4. Apply a clock to DCKIP/N at  $f_{DAC}/4$  for dual-port mode or  $f_{DAC}/2$  for single-port mode.
- 5. Apply zeroes to ports A and B (DAP/N, DBP/N) for dual-port mode, or only to port B for single-port mode.

- 6. Write to address 0x03 to enable the DCKIP/N LVDS receiver. Set address 0x03 to 0x01 if the LVDS clock (DCKI) and data (DA, DB) are in phase with each other. Set address 0x03 to 0x05 if they are in quadrature.
- 7. Write 0x03 to address 0x04 for dual-port mode, or write 0x06 to address 0x04 for single-port mode to enable the DAP/N and DBP/N LVDS receivers.
- 8. Wait at least 1ms for the synchronizer to finish initializing.
- Write 0x0B to address 0x04 for dual-port mode, or write 0x0E to address 0x04 for single-port mode to set DATA\_EN = 1.

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 Apply desired data pattern to ports A and B (DAP/N, DBP/N) for dual-port mode, or only to port B for single-port mode. Port A samples will precede port B samples at the DAC output when using dual-port mode.

#### **Output Configurations**

The LTC2000A's complementary current outputs ( $I_{OUTP/N}$ ) source current into an external load referenced to GND. Output load configuration, component selection, and layout are critical to the performance of the LTC2000A. For best AC performance, the output stages should be configured for differential (or balanced) operation.

A differential resistor loaded output is a very simple output stage. Well matched resistors are connected between GND and  $I_{OUTP/N}$ , with the resistance values setting both the output swing and non-zero output common-mode voltage (Figure 9). While it is economical, this type of output stage can drive only differential loads with impedance levels and amplitudes appropriate for the DAC outputs.

Differential transformer-coupled output configurations usually give the best AC performance and provide excellent rejection of common mode distortion and noise over a broad frequency range. Figure 10 shows a transformer output configuration that uses a Mini-Circuits TC1-1-13M and a JTX-2-10T RF transformer for differential to singleended conversion. For any output configuration, any imbalances in the output impedance between the  $I_{OUTP}$  and  $I_{OUTN}$  pins results in asymmetrical signal swings that lead to distortion (mostly even order). Careful consideration is needed to select the best output configuration for a given application.

#### **Generating the DAC Sample Clock**

For best AC performance, it is important that the DAC sample clock waveforms be clean, with low phase noise and good jitter performance, as the phase noise and spurious content of the clock source will appear directly in the DAC output spectrum.

A differential clock should be AC coupled onto the CKP/N pins, since the DC bias point of CKP/N is set internally to 1V through a  $5k\Omega$  impedance. Figure 11 shows the DAC sample clock receiver input and common-mode voltage control. While the differential input voltage range of the clock receiver spans from  $\pm 300$  mV to  $\pm 1.8$ V, a signal with the highest possible slew rate and amplitude and a balanced duty cycle is recommended. Traces that carry the differential clock signal need to have accurately controlled impedance and accurate termination as close to the CKP/N pins of the LTC2000A as possible.

There are several ways to generate the DAC sample clock. For lab evaluation and testing, a high quality RF signal generator can provide a clean high frequency sine wave that is converted to the DAC sample clock with a 1:1 RF transformer or balun (see Figure 12).

![](_page_35_Figure_12.jpeg)

Figure 9. Differential Resistor Output Load

![](_page_35_Figure_14.jpeg)

Figure 10. Transformer-Based Output Configuration for Differential to Single-Ended Conversion

![](_page_35_Figure_16.jpeg)

Figure 11. DAC Sample Clock Receiver

![](_page_36_Figure_2.jpeg)

Figure 12. DAC Sample Clock Generation with an RF Signal Generator and a 1:1 Balun

A more integrated clock source is one based on a low phase noise, low jitter PLL. Figure 13 shows how the DAC sample clock can be generated from the LTC6946, a high performance PLL with an internal VCO that can provide output frequencies from 0.37GHz to 5.7GHz. See the LTC6946 data sheet for details.

#### Synchronizing Multiple LTC2000As in Dual-Port Mode

In some applications, it is necessary to synchronize multiple LTC2000As to each other such that related samples arrive at all DAC outputs simultaneously. Figures 14 and 15a show a block diagram and sample waveforms for such a system in which two DACs (X and Y) are to be synchronized in dual-port mode.

Note that in this example a small timing skew between the two data signals at the DCKIP/N pins of DACs X and Y has caused the DCKIP/N rising edges to arrive on opposite sides of a DAC sample clock (CKP/N) rising edge, and thus within different CKP/N clock cycles. As a result the default behavior is for the output of DAC Y to update with sample N one cycle earlier than the output of DAC X. It is possible to correct this misalignment and synchronize DACs X and Y by adjusting the clock synchronizer settings to subtract one cycle of latency from DAC X, as shown in the adjusted waveform at the bottom of Figure 15a. See the Clock Synchronizer section and Figure 7 for more details on the operation of the clock synchronizer.

In order to synchronize multiple DACs as shown in Figures 14 and 15a, distribute the DAC sample clock carefully with matched delays so that it arrives at the CKP/N pins of all DACs simultaneously. Any remaining timing mismatch between sample clocks will appear directly as mismatch in the DAC output timing. Ensure that the timing mismatch between LVDS data clock signals at the DCKIP/N pins of all DACs is less than 0.4 cycles of the DAC sample clocks. Be sure to maintain sufficient matching between the timing of the LVDS data inputs (DAP/N, DBP/N) and DCKIP/N for each DAC to meet the setup and hold time specifications  $(t_{11}, t_{12})$  in the Timing Characteristics section.

For example, let us consider a system using multiple DACs at 2.7Gsps in which the sample clock is designed to arrive at the CKP/N pins of all DACs within 30ps of one another. The sample clock period is 370ps, so the maximum allowable timing mismatch between the data clock signals at the DCKIP/N pins of all DACs will be  $(0.4 \cdot 370ps) - 30ps = 118ps$ . For a system using multiple DACs at 1.35Gsps, the allowable mismatch between DCKIP/N pins will be  $(0.4 \cdot 740ps) - 30ps = 266ps$ . In both cases, once the DACs

![](_page_36_Figure_11.jpeg)

Figure 13. DAC Sample Clock Generation with the LTC6946

![](_page_37_Figure_2.jpeg)

Figure 14. System with Multiple LTC2000A DACs Synchronized

![](_page_37_Figure_4.jpeg)

Figure 15a. Sample Waveforms — Synchronizing Multiple LTC2000As in Dual Port Mode

are synchronized the mismatch in the DAC output timing will be limited to 30ps.

Once all the DAC sample clocks and LVDS data clocks are aligned, determine whether any DACs are being updated one cycle late (such as DAC X in Figure 15a) by determining whether DCKIP/N is arriving at the DACs within the same CKP/N clock cycle. To do this in dual-port mode, first use the phase comparator outputs SYNC\_PH and Table 12 to determine the delay from the DCKIP/N rising edge to the next CKP/N rising edge for each DAC (measured in sample clock cycles). Recall that the DCKIP/N timing mismatch must be kept below 0.4 cycles of the sample clock. If DCKIP/N arrives at both DACs within the same sample clock cycle, the difference in DCKIP/N to CKP/N delays indicated by SYNC\_PH will equal the actual DCKIP/N timing mismatch, and thus will be less than 0.4 cycles. If DCKIP/N arrives at the DACs within different cycles, as in Figure 15a, the difference in the delays indicated by SYNC\_PH will equal 1 cycle minus the actual DCKIP/N timing mismatch, and thus will be greater than 0.4 cycles. Thus if the difference between the delays indicated by SYNC\_PH is greater than

0.4 cycles, the DCKIP/N rising edges are arriving in different sample clock cycles.

For the example in Figure 15a, we might read 0x25 for SYNC\_PH on DAC X and 0x52 on DAC Y. Table 12 tells us that the DCKIP/N to CKP/N delay is greater than 0.8 cycles for DAC X and less than 0.2 cycles for DAC Y, and thus the difference between them is at least 0.6 cycles. We conclude that the DCKIP/N rising edge of DAC X must fall within a later sample clock cycle than that of DAC Y, and thus that DAC X is being updated one cycle later than DAC Y.

To correct any such misalignment and synchronize the DACs, consult Table 12 and adjust the SYNC\_PS settings for those DACs which are being updated one cycle late (DAC X in the above example) by setting the synchronizer to manual mode (SYNC\_MSYN = 1) and overwriting the SYNC\_PS value.

In this example, reading register 0x06 of DAC X shows SYNC\_PH = 0x25 and that the SYNC\_PS setting needs to change from the default (10) to the desired adjusted value (00), subtracting one cycle from the latency of DAC X (refer to Table 12). Write 0x04 to register 0x05 of DAC X to set SYNC\_MSYN = 1 and SYNC\_PS = 00. The outputs of DAC X should now align with DAC Y as shown in Figure 15a. See Table 6 for details regarding the synchronizer registers 0x05 and 0x06. Sample verilog code implementing the synchronization of multiple LTC2000As using Tables 12 and 13 can be found at:

#### http://www.linear.com/docs/44845

#### Synchronizing Multiple LTC2000As in Single-Port Mode

Figure 15b shows sample waveforms for synchronizing two LTC2000As in single port mode. Synchronizing multiple LTC2000As in single port mode is essentially the same

|  | DELAY FROM DCKIP/N BISING                        | SYNC_PS SETTING |   |  |  |  |  |
|--|--|-----------------|---|--|--|--|--|
| PHASE COMPARATOR OUTPUTS<br>Sync_ph (reg 0x06) | EDGE TO NEXT CKP/N RISING EDGE<br>(CKP/N CYCLES) | (DEFAULT)       | (ADJUSTED TO REDUCE LATENCY<br>BY 1 CYCLE)* |  |  |  |  |
| 0x03   | 0 to 0.2   | 10              | N/A   |  |  |  |  |
| 0x04   | 0.2 to 0.4                                       | 10              | N/A   |  |  |  |  |
| 0x05   | 0.4 to 0.6                                       | 10              | N/A   |  |  |  |  |
| 0x15   | 0.6 to 0.8                                       | 10              | 00  |  |  |  |  |
| 0x25   | 0.8 to 1.0                                       | 10              | 00  |  |  |  |  |
| 0x35   | 0 to 0.2   | 00              | N/A   |  |  |  |  |
| 0x45   | 0.2 to 0.4                                       | 00              | N/A   |  |  |  |  |
| 0x55   | 0.4 to 0.6                                       | 00              | N/A   |  |  |  |  |
| 0x54   | 0.6 to 0.8                                       | 00              | 01  |  |  |  |  |
| 0x53   | 0.8 to 1.0                                       | 00              | 01  |  |  |  |  |
| 0x52   | 0 to 0.2   | 01              | N/A   |  |  |  |  |
| 0x51   | 0.2 to 0.4                                       | 01              | N/A   |  |  |  |  |
| 0x50   | 0.4 to 0.6                                       | 01              | N/A   |  |  |  |  |
| 0x40   | 0.6 to 0.8                                       | 01              | 11  |  |  |  |  |
| 0x30   | 0.8 to 1.0                                       | 01              | 11  |  |  |  |  |
| 0x20   | 0 to 0.2   | 11              | N/A   |  |  |  |  |
| 0x10   | 0.2 to 0.4                                       | 11              | N/A   |  |  |  |  |
| 0x00   | 0.4 to 0.6                                       | 11              | N/A   |  |  |  |  |
| 0x01   | 0.6 to 0.8                                       | 11              | 10  |  |  |  |  |
| 0x02   | 0.8 to 1.0                                       | 11              | 10  |  |  |  |  |

#### Table 12. Adjusting Latency in Dual-Port Mode

\*N/A indicate SYNC\_PH values that should not occur if the timing mismatch requirements described above are met. If such a case occurs, keep SYNC\_PS as the default value.

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![](_page_39_Figure_2.jpeg)

Figure 15b. Sample Waveforms — Synchronizing Multiple LTC2000As in Single Port Mode

procedure as when operating in dual port mode—DAC sample clocks must all be aligned to arrive at the CKP/N pins of all DACs simultaneously and timing mismatch between LVDS data clock signals at the DCKIP/N pins of all DACs must be less than 0.4 cycles of the DAC sample clock, minus any timing mismatch between the DAC sample clocks.

To determine whether any DACs are being updated one cycle late in single port mode, first use the phase comparator outputs SYNC\_PH and Table 13 to determine the delay from the DCKIP/N rising edge to the next CKP/N falling edge (as opposed to rising edge in dual port mode) for each DAC. If the difference between the delays indicated by SYNC\_PH is greater than 0.4 cycles, the DCKIP/N rising edges are arriving in different sample clock cycles.

For the example in Figure 15b, we might read 0x15 for SYNC\_PH on DAC X and 0x20 on DAC Y. Table 13 shows that the DCKIP/N to CKP/N delay is greater than 0.8 cycles for DAC X and less than 0.1 cycles for DAC Y, and thus the difference between them is at least 0.7 cycles. This indicates that DAC X is being updated one cycle later than DAC Y. Consult Table 13 and use the same procedure described above in the dual-port mode case to correct the SYNC\_PS

settings for those DACs that are updating one cycle late. In this single port example, writing 0x06 to register 0x05 of DAC X would set SYNC\_MSYN = 1 and SYNC\_PS = 10, reducing the latency of DAC X by one cycle and aligning its output with DAC Y, as shown in Figure 15b.

Note that variations in system temperature or supply voltage may cause the phase of the data clock (DCKIP/N) and sample clock (CKP/N) to vary with time. When using the LTC2000A with SYNC\_MSYN = 1, it is recommended that users monitor SYNC\_PH and adjust SYNC\_PS using Tables 12 or 13 as needed to maintain proper alignment.

The synchronization procedures described above also work for systems with more than two DACs. Simply determine the minimum DCKIP/N to CKP/N delay of all DACs by reading SYNC\_PH, and then adjust the SYNC\_PS settings to subtract one cycle of latency to those DACs whose DCKIP/N to CKP/N delays are at least 0.4 cycles more than the minimum. Sample verilog code implementing the synchronization of multiple LTC2000As using Tables 12 and 13 can be found at:

http://www.linear.com/docs/44845

|  | Table 13. | Adjusting | Latency | in | Single-Port | Mode |
|--|-----------|-----------|---------|----|-------------|------|
|--|-----------|-----------|---------|----|-------------|------|

|  | DELAY FROM DCKIP/N RISING                         | SYNC_PS SETTING |   |  |  |  |  |
|--|---|-----------------|---|--|--|--|--|
| PHASE COMPARATOR OUTPUTS<br>Sync_ph (reg 0x06) | EDGE TO NEXT CKP/N FALLING<br>EDGE (CKP/N CYCLES) | (DEFAULT)       | (ADJUSTED TO REDUCE LATENCY<br>BY 1 CYCLE)* |  |  |  |  |
| 0×03   | 0.5 to 0.6  | 00              | N/A   |  |  |  |  |
| 0×04   | 0.6 to 0.7  | 00              | 10  |  |  |  |  |
| 0×05   | 0.7 to 0.8  | 00              | 10  |  |  |  |  |
| 0x15   | 0.8 to 0.9  | 00              | 10  |  |  |  |  |
| 0x25   | 0.9 to 1.0  | 00              | 10  |  |  |  |  |
| 0x35   | 0 to 0.1  | 10              | N/A   |  |  |  |  |
| 0x45   | 0.1 to 0.2  | 10              | N/A   |  |  |  |  |
| 0x55   | 0.2 to 0.3  | 10              | N/A   |  |  |  |  |
| 0x54   | 0.3 to 0.4  | 10              | N/A   |  |  |  |  |
| 0x53   | 0.4 to 0.5  | 10              | N/A   |  |  |  |  |
| 0x52   | 0.5 to 0.6  | 10              | N/A   |  |  |  |  |
| 0x51   | 0.6 to 0.7  | 10              | 00  |  |  |  |  |
| 0x50   | 0.7 to 0.8  | 10              | 00  |  |  |  |  |
| 0x40   | 0.8 to 0.9  | 10              | 00  |  |  |  |  |
| 0x30   | 0.9 to 1.0  | 10              | 00  |  |  |  |  |
| 0x20   | 0 to 0.1  | 00              | N/A   |  |  |  |  |
| 0x10   | 0.1 to 0.2  | 00              | N/A   |  |  |  |  |
| 0x00   | 0.2 to 0.3  | 00              | N/A   |  |  |  |  |
| 0x01   | 0.3 to 0.4  | 00              | N/A   |  |  |  |  |
| 0x02   | 0.4 to 0.5  | 00              | N/A   |  |  |  |  |

\*N/A indicate SYNC\_PH values that should not occur if the timing mismatch requirements described above are met. If such a case occurs, keep SYNC\_PS as the default value.

#### **PCB Layout Considerations**

The close proximity of high frequency digital data lines and high dynamic range, wideband analog signals make clean printed circuit board design and layout an absolute necessity. Figures 16 and 17 show a schematic and PCB layers for an evaluation circuit for the LTC2000A. A single, solid ground plane should be used, while separate supply planes for AV<sub>DD18</sub>, DV<sub>DD18</sub>, AV<sub>DD33</sub>, and DV<sub>DD33</sub> should be kept all the way to the individual supply or LDO. All LVDS input (DCKIP/N, DAP/N, DBP/N) board traces must be carefully matched to ensure proper phase alignment. These LVDS inputs should be kept far away from both the I<sub>OUTP/N</sub> and CKP/N traces to avoid any data dependent coupling into the analog output and DAC sample clock. The CKP/N traces should be routed either over the analog ground plane or over their own section on the ground plane. These traces also need to have accurately controlled impedance and should be well terminated near the LTC2000A. The  $I_{OUTP/N}$  traces should also be carefully matched to each other, routed over the ground plane, away from the LVDS inputs and CKP/N signals.

Bypass capacitors are required on AV<sub>DD18</sub>, DV<sub>DD18</sub>, AV<sub>DD33</sub>, and DV<sub>DD33</sub>, and should all be connected to the analog ground plane. 2.2 $\mu$ F ceramic capacitors with low ESR are recommended to be placed close to the LTC2000A with minimum trace lengths. A sample PCB layout and schematic can be found below.

![](_page_41_Figure_2.jpeg)

![](_page_41_Figure_3.jpeg)

![](_page_41_Figure_4.jpeg)

![](_page_41_Figure_5.jpeg)

![](_page_41_Figure_6.jpeg)

![](_page_41_Figure_7.jpeg)

![](_page_42_Figure_2.jpeg)

Layer 3

![](_page_42_Figure_4.jpeg)

Layer 4

![](_page_43_Figure_2.jpeg)

Layer 5

![](_page_43_Figure_4.jpeg)

Layer 6

![](_page_44_Figure_2.jpeg)

Layer 7

![](_page_44_Figure_4.jpeg)

Layer 8

Figure 17

## PIN LOCATIONS (LTC2000A-16)

#### LTC2000A-16 BGA Pinout

| PIN ID | FUNCTION           | PIN ID | FUNCTION |
|--------|--------------------|--------|--------------------|--------|--------------------|--------|--------------------|--------|--------------------|--------|----------|
| A1     | GND                | B1     | GND                | C1     | AV <sub>DD18</sub> | D1     | AV <sub>DD18</sub> | E1     | AV <sub>DD18</sub> | F1     | GND      |
| A2     | CKN                | B2     | GND                | C2     | AV <sub>DD18</sub> | D2     | AV <sub>DD18</sub> | E2     | AV <sub>DD18</sub> | F2     | GND      |
| A3     | СКР                | B3     | GND                | C3     | AV <sub>DD18</sub> | D3     | AV <sub>DD18</sub> | E3     | DV <sub>DD18</sub> | F3     | GND      |
| A4     | GND                | B4     | GND                | C4     | AV <sub>DD18</sub> | D4     | DV <sub>DD18</sub> | E4     | DV <sub>DD18</sub> | F4     | GND      |
| A5     | DV <sub>DD18</sub> | B5     | DV <sub>DD18</sub> | C5     | DV <sub>DD18</sub> | D5     | DV <sub>DD18</sub> | E5     | DV <sub>DD18</sub> | F5     | GND      |
| A6     | GND                | B6     | GND                | C6     | GND                | D6     | GND                | E6     | GND                | F6     | GND      |
| A7     | DAN15              | B7     | DAN14              | C7     | DAN13              | D7     | DAN12              | E7     | DAN11              | F7     | DAN10    |
| A8     | DAP15              | B8     | DAP14              | C8     | DAP13              | D8     | DAP12              | E8     | DAP11              | F8     | DAP10    |
| A9     | DBN15              | B9     | DBN14              | C9     | DBN13              | D9     | DBN12              | E9     | DBN11              | F9     | DBN10    |
| A10    | DBP15              | B10    | DBP14              | C10    | DBP13              | D10    | DBP12              | E10    | DBP11              | F10    | DBP10    |

| PIN ID | FUNCTION | PIN ID | FUNCTION          | PIN ID | FUNCTION          | PIN ID | FUNCTION | PIN ID | FUNCTION | PIN ID | FUNCTION           |
|--------|----------|--------|-------------------|--------|-------------------|--------|----------|--------|----------|--------|--------------------|
| G1     | GND      | H1     | I <sub>OUTP</sub> | J1     | I <sub>OUTN</sub> | K1     | GND      | L1     | GND      | M1     | REFIO              |
| G2     | GND      | H2     | GND               | J2     | GND               | K2     | GND      | L2     | GND      | M2     | FSADJ              |
| G3     | GND      | H3     | GND               | J3     | GND               | K3     | GND      | L3     | GND      | M3     | GND                |
| G4     | GND      | H4     | GND               | J4     | GND               | K4     | GND      | L4     | GND      | M4     | AV <sub>DD33</sub> |
| G5     | GND      | H5     | GND               | J5     | GND               | K5     | GND      | L5     | GND      | M5     | DV <sub>DD33</sub> |
| G6     | GND      | H6     | GND               | J6     | GND               | K6     | GND      | L6     | GND      | M6     | GND                |
| G7     | DAN9     | H7     | DAN8              | J7     | DCKON             | K7     | DAN7     | L7     | DAN6     | M7     | DAN5               |
| G8     | DAP9     | H8     | DAP8              | J8     | DCKOP             | K8     | DAP7     | L8     | DAP6     | M8     | DAP5               |
| G9     | DBN9     | H9     | DBN8              | J9     | DCKIN             | K9     | DBN7     | L9     | DBN6     | M9     | DBN5               |
| G10    | DBP9     | H10    | DBP8              | J10    | DCKIP             | K10    | DBP7     | L10    | DBP6     | M10    | DBP5               |

| PIN ID | FUNCTION           | PIN ID | FUNCTION           | PIN ID | FUNCTION           | PIN ID | FUNCTION | PIN ID | FUNCTION         |
|--------|--------------------|--------|--------------------|--------|--------------------|--------|----------|--------|------------------|
| N1     | GND                | P1     | AV <sub>DD33</sub> | Q1     | AV <sub>DD33</sub> | R1     | GND      | S1     | PD               |
| N2     | GND                | P2     | AV <sub>DD33</sub> | Q2     | AV <sub>DD33</sub> | R2     | GND      | S2     | CS               |
| N3     | GND                | P3     | AV <sub>DD33</sub> | Q3     | AV <sub>DD33</sub> | R3     | TSTN     | S3     | SDO              |
| N4     | AV <sub>DD33</sub> | P4     | AV <sub>DD33</sub> | Q4     | AV <sub>DD33</sub> | R4     | TSTP     | S4     | SDI              |
| N5     | DV <sub>DD33</sub> | P5     | DV <sub>DD33</sub> | Q5     | DV <sub>DD33</sub> | R5     | GND      | S5     | SCK              |
| N6     | GND                | P6     | GND                | Q6     | GND                | R6     | GND      | S6     | SV <sub>DD</sub> |
| N7     | DAN4               | P7     | DAN3               | Q7     | DAN2               | R7     | DAN1     | S7     | DAN0             |
| N8     | DAP4               | P8     | DAP3               | Q8     | DAP2               | R8     | DAP1     | S8     | DAP0             |
| N9     | DBN4               | P9     | DBN3               | Q9     | DBN2               | R9     | DBN1     | S9     | DBN0             |
| N10    | DBP4               | P10    | DBP3               | Q10    | DBP2               | R10    | DBP1     | S10    | DBPO             |

### LTC2000A

### PIN LOCATIONS (LTC2000A-16)

![](_page_46_Picture_2.jpeg)

![](_page_46_Picture_3.jpeg)

## PIN LOCATIONS (LTC2000A-14)

#### LTC2000A-14 BGA Pinout

| PIN ID | FUNCTION           | PIN ID | FUNCTION |
|--------|--------------------|--------|--------------------|--------|--------------------|--------|--------------------|--------|--------------------|--------|----------|
| A1     | GND                | B1     | GND                | C1     | AV <sub>DD18</sub> | D1     | AV <sub>DD18</sub> | E1     | AV <sub>DD18</sub> | F1     | GND      |
| A2     | CKN                | B2     | GND                | C2     | AV <sub>DD18</sub> | D2     | AV <sub>DD18</sub> | E2     | AV <sub>DD18</sub> | F2     | GND      |
| A3     | СКР                | B3     | GND                | C3     | AV <sub>DD18</sub> | D3     | AV <sub>DD18</sub> | E3     | DV <sub>DD18</sub> | F3     | GND      |
| A4     | GND                | B4     | GND                | C4     | AV <sub>DD18</sub> | D4     | DV <sub>DD18</sub> | E4     | DV <sub>DD18</sub> | F4     | GND      |
| A5     | DV <sub>DD18</sub> | B5     | DV <sub>DD18</sub> | C5     | DV <sub>DD18</sub> | D5     | DV <sub>DD18</sub> | E5     | DV <sub>DD18</sub> | F5     | GND      |
| A6     | GND                | B6     | GND                | C6     | GND                | D6     | GND                | E6     | GND                | F6     | GND      |
| A7     | DAN13              | B7     | DAN12              | C7     | DAN11              | D7     | DAN10              | E7     | DAN9               | F7     | DAN8     |
| A8     | DAP13              | B8     | DAP12              | C8     | DAP11              | D8     | DAP10              | E8     | DAP9               | F8     | DAP8     |
| A9     | DBN13              | B9     | DBN12              | C9     | DBN11              | D9     | DBN10              | E9     | DBN9               | F9     | DBN8     |
| A10    | DBP13              | B10    | DBP12              | C10    | DBP11              | D10    | DBP10              | E10    | DBP9               | F10    | DBP8     |

| PIN ID | FUNCTION | PIN ID | FUNCTION          | PIN ID | FUNCTION          | PIN ID | FUNCTION | PIN ID | FUNCTION | PIN ID | FUNCTION           |
|--------|----------|--------|-------------------|--------|-------------------|--------|----------|--------|----------|--------|--------------------|
| G1     | GND      | H1     | I <sub>OUTP</sub> | J1     | I <sub>OUTN</sub> | K1     | GND      | L1     | GND      | M1     | REFIO              |
| G2     | GND      | H2     | GND               | J2     | GND               | K2     | GND      | L2     | GND      | M2     | FSADJ              |
| G3     | GND      | H3     | GND               | J3     | GND               | K3     | GND      | L3     | GND      | M3     | GND                |
| G4     | GND      | H4     | GND               | J4     | GND               | K4     | GND      | L4     | GND      | M4     | AV <sub>DD33</sub> |
| G5     | GND      | H5     | GND               | J5     | GND               | K5     | GND      | L5     | GND      | M5     | DV <sub>DD33</sub> |
| G6     | GND      | H6     | GND               | J6     | GND               | K6     | GND      | L6     | GND      | M6     | GND                |
| G7     | DAN7     | H7     | DAN6              | J7     | DCKON             | K7     | DAN5     | L7     | DAN4     | M7     | DAN3               |
| G8     | DAP7     | H8     | DAP6              | J8     | DCKOP             | K8     | DAP5     | L8     | DAP4     | M8     | DAP3               |
| G9     | DBN7     | H9     | DBN6              | J9     | DCKIN             | K9     | DBN5     | L9     | DBN4     | M9     | DBN3               |
| G10    | DBP7     | H10    | DBP6              | J10    | DCKIP             | K10    | DBP5     | L10    | DBP4     | M10    | DBP3               |

| PIN ID | FUNCTION           | PIN ID | FUNCTION           | PIN ID | FUNCTION           | PIN ID | FUNCTION | PIN ID | FUNCTION         |
|--------|--------------------|--------|--------------------|--------|--------------------|--------|----------|--------|------------------|
| N1     | GND                | P1     | AV <sub>DD33</sub> | Q1     | AV <sub>DD33</sub> | R1     | GND      | S1     | PD               |
| N2     | GND                | P2     | AV <sub>DD33</sub> | Q2     | AV <sub>DD33</sub> | R2     | GND      | S2     | CS               |
| N3     | GND                | P3     | AV <sub>DD33</sub> | Q3     | AV <sub>DD33</sub> | R3     | TSTN     | S3     | SDO              |
| N4     | AV <sub>DD33</sub> | P4     | AV <sub>DD33</sub> | Q4     | AV <sub>DD33</sub> | R4     | TSTP     | S4     | SDI              |
| N5     | DV <sub>DD33</sub> | P5     | DV <sub>DD33</sub> | Q5     | DV <sub>DD33</sub> | R5     | GND      | S5     | SCK              |
| N6     | GND                | P6     | GND                | Q6     | GND                | R6     | GND      | S6     | SV <sub>DD</sub> |
| N7     | DAN2               | P7     | DAN1               | Q7     | DANO               | R7     | GND      | S7     | GND              |
| N8     | DAP2               | P8     | DAP1               | Q8     | DAP0               | R8     | GND      | S8     | GND              |
| N9     | DBN2               | P9     | DBN1               | Q9     | DBN0               | R9     | GND      | S9     | GND              |
| N10    | DBP2               | P10    | DBP1               | Q10    | DBP0               | R10    | GND      | S10    | GND              |

### LTC2000A

### PIN LOCATIONS (LTC2000A-14)

![](_page_48_Picture_2.jpeg)

![](_page_48_Picture_3.jpeg)

## PIN LOCATIONS (LTC2000A-11)

#### LTC2000A-11 BGA Pinout

| PIN ID | FUNCTION           | PIN ID | FUNCTION |
|--------|--------------------|--------|--------------------|--------|--------------------|--------|--------------------|--------|--------------------|--------|----------|
| A1     | GND                | B1     | GND                | C1     | AV <sub>DD18</sub> | D1     | AV <sub>DD18</sub> | E1     | AV <sub>DD18</sub> | F1     | GND      |
| A2     | CKN                | B2     | GND                | C2     | AV <sub>DD18</sub> | D2     | AV <sub>DD18</sub> | E2     | AV <sub>DD18</sub> | F2     | GND      |
| A3     | СКР                | B3     | GND                | C3     | AV <sub>DD18</sub> | D3     | AV <sub>DD18</sub> | E3     | DV <sub>DD18</sub> | F3     | GND      |
| A4     | GND                | B4     | GND                | C4     | AV <sub>DD18</sub> | D4     | DV <sub>DD18</sub> | E4     | DV <sub>DD18</sub> | F4     | GND      |
| A5     | DV <sub>DD18</sub> | B5     | DV <sub>DD18</sub> | C5     | DV <sub>DD18</sub> | D5     | DV <sub>DD18</sub> | E5     | DV <sub>DD18</sub> | F5     | GND      |
| A6     | GND                | B6     | GND                | C6     | GND                | D6     | GND                | E6     | GND                | F6     | GND      |
| A7     | DAN10              | B7     | DAN9               | C7     | DAN8               | D7     | DAN7               | E7     | DAN6               | F7     | DAN5     |
| A8     | DAP10              | B8     | DAP9               | C8     | DAP8               | D8     | DAP7               | E8     | DAP6               | F8     | DAP5     |
| A9     | DBN10              | B9     | DBN9               | C9     | DBN8               | D9     | DBN7               | E9     | DBN6               | F9     | DBN5     |
| A10    | DBP10              | B10    | DBP9               | C10    | DBP8               | D10    | DBP7               | E10    | DBP6               | F10    | DBP5     |

| PIN ID | FUNCTION | PIN ID | FUNCTION          | PIN ID | FUNCTION          | PIN ID | FUNCTION | PIN ID | FUNCTION | PIN ID | FUNCTION           |
|--------|----------|--------|-------------------|--------|-------------------|--------|----------|--------|----------|--------|--------------------|
| G1     | GND      | H1     | I <sub>OUTP</sub> | J1     | I <sub>OUTN</sub> | K1     | GND      | L1     | GND      | M1     | REFI0              |
| G2     | GND      | H2     | GND               | J2     | GND               | K2     | GND      | L2     | GND      | M2     | FSADJ              |
| G3     | GND      | H3     | GND               | J3     | GND               | K3     | GND      | L3     | GND      | M3     | GND                |
| G4     | GND      | H4     | GND               | J4     | GND               | K4     | GND      | L4     | GND      | M4     | AV <sub>DD33</sub> |
| G5     | GND      | H5     | GND               | J5     | GND               | K5     | GND      | L5     | GND      | M5     | DV <sub>DD33</sub> |
| G6     | GND      | H6     | GND               | J6     | GND               | K6     | GND      | L6     | GND      | M6     | GND                |
| G7     | DAN4     | H7     | DAN3              | J7     | DCKON             | K7     | DAN2     | L7     | DAN1     | M7     | DAN0               |
| G8     | DAP4     | H8     | DAP3              | J8     | DCKOP             | K8     | DAP2     | L8     | DAP1     | M8     | DAP0               |
| G9     | DBN4     | H9     | DBN3              | J9     | DCKIN             | K9     | DBN2     | L9     | DBN1     | M9     | DBN0               |
| G10    | DBP4     | H10    | DBP3              | J10    | DCKIP             | K10    | DBP2     | L10    | DBP1     | M10    | DBP0               |

| PIN ID | FUNCTION           | PIN ID | FUNCTION           | PIN ID | FUNCTION           | PIN ID | FUNCTION | PIN ID | FUNCTION         |
|--------|--------------------|--------|--------------------|--------|--------------------|--------|----------|--------|------------------|
| N1     | GND                | P1     | AV <sub>DD33</sub> | Q1     | AV <sub>DD33</sub> | R1     | GND      | S1     | PD               |
| N2     | GND                | P2     | AV <sub>DD33</sub> | Q2     | AV <sub>DD33</sub> | R2     | GND      | S2     | CS               |
| N3     | GND                | P3     | AV <sub>DD33</sub> | Q3     | AV <sub>DD33</sub> | R3     | TSTN     | S3     | SDO              |
| N4     | AV <sub>DD33</sub> | P4     | AV <sub>DD33</sub> | Q4     | AV <sub>DD33</sub> | R4     | TSTP     | S4     | SDI              |
| N5     | DV <sub>DD33</sub> | P5     | DV <sub>DD33</sub> | Q5     | DV <sub>DD33</sub> | R5     | GND      | S5     | SCK              |
| N6     | GND                | P6     | GND                | Q6     | GND                | R6     | GND      | S6     | SV <sub>DD</sub> |
| N7     | GND                | P7     | GND                | Q7     | GND                | R7     | GND      | S7     | GND              |
| N8     | GND                | P8     | GND                | Q8     | GND                | R8     | GND      | S8     | GND              |
| N9     | GND                | P9     | GND                | Q9     | GND                | R9     | GND      | S9     | GND              |
| N10    | GND                | P10    | GND                | Q10    | GND                | R10    | GND      | S10    | GND              |

### LTC2000A

### PIN LOCATIONS (LTC2000A-11)

![](_page_50_Picture_2.jpeg)

### PACKAGE DESCRIPTION

Please refer to http://www.linear.com/product/LTC2000A#packaging for the most recent package drawings.

![](_page_51_Figure_3.jpeg)

### **REVISION HISTORY**

| REV | DATE  | DESCRIPTION   | PAGE NUMBER |
|-----|-------|---|-------------|
| Α   | 05/17 | Added lead-finish option  | 4           |
| В   | 12/17 | Updated Measuring Internal Junction Temperature text to clarify series cancellation requirement | 33          |

### TYPICAL APPLICATION

LTC2000A High Speed DAC Driving LT5579 Mixer as an Upconverting Transmitter with Low Noise Power Supply Solution

![](_page_53_Figure_3.jpeg)

### **RELATED PARTS**

| PART NUMBER                 | DESCRIPTION   | COMMENTS   |
|-----------------------------|---|--|
| LTC1666/LTC1667/<br>LTC1668 | 12-/14-/16-Bit 50Msps DACs with 10mA Full Scale                       | $V_{CC} = \pm 5V$ , -1V to 1V Output Compliance, 28-Pin SSOP Package                                     |
| LTC2000                     | 16-/14-/11-Bit 2.5Gsps DAC  | 68dBc SFDR from DC to 1000MHz, 170-Lead BGA Package  |
| LTC2153/LTC2158             | Single/Dual 14-/12-Bit 310Msps ADCs                                   | 88dB SFDR, 1.25GHz Bandwidth Sample-and-Hold   |
| LTC2630                     | Single 12-/10-/8-Bit Rail-to-Rail DACs with Internal Reference        | V <sub>CC</sub> = 2.7V to 5.5V, SC70 Package   |
| LTC2991                     | Octal I <sup>2</sup> C Voltage, Current, and Temperature Monitor      | V <sub>CC</sub> = 3V to 5.5V, 16-Lead MSOP Package   |
| LTC2997                     | Remote/Internal Temperature Sensor                                    | V <sub>CC</sub> = 2.V to 5.5V, 170µA, 6-Lead 2mm × 3mm DFN Package                                       |
| LT <sup>®</sup> 5521        | Very High Linearity Active Mixer                                      | 10MHz to 3.7GHz, 24.2dBm OIP3 at 1.95GHz   |
| LT5579                      | High Linearity Upconverting Mixer                                     | 1.5GHz to 3.8GHz, 27.3dBm OIP3 at 2.14GHz  |
| LT5578                      | High Linearity Upconverting Mixer                                     | 400MHz to 2.7GHz, 24.3dBm IIP3 at 1.95GHz  |
| LTC6406                     | 3GHz, Low Noise, Rail-to-Rail Input Differential<br>Amplifier/Driver  | Low Noise: 1.6nV/ $\sqrt{\text{Hz}}$ RTI , 18mA at 3V, Low Distortion                                    |
| LTC6430-15                  | High Linearity Differential RF/IF Amplifier                           | 20MHz to 2GHz Bandwidth, 50dBm OIP3 at 240MHz, 15.2dB Gain   |
| LTC6946                     | Ultralow Noise and Spurious Integer-N Synthesizer with Integrated VCO | 0.37GHz to 5.7GHz, –226dBc/Hz Normalized In-Band Phase Noise,<br>–274dBc/Hz Normalized In-Band 1/f Noise |

![](_page_53_Picture_6.jpeg)

![](_page_53_Picture_7.jpeg)